

Micropower, 3-Axis, ±200 g Digital Output, MEMS Accelerometer

FEATURES

- ▶ ±200 g measurement range
- ▶ 200 Hz to 3200 Hz user selectable bandwidth with 4-pole antialiasing filter
- ▶ Selectable oversampling ratio
- Adjustable high-pass filter
- Ultralow power
 - ▶ Power can be derived from a coin cell battery
 - ▶ 22 µA at 3200 Hz ODR, 2.5 V supply
 - ▶ Low power, wake-up mode for low *g* activity detection
 - ▶ 1.4 µA instant on mode with adjustable threshold
 - ► <0.1 µA standby mode
- ▶ Built in features for system level power savings
 - Autonomous interrupt processing without processor intervention
 - ▶ Deep embedded FIFO to minimize host processor load
- ▶ Ultralow power event monitoring detects impacts and wakes up fast enough to capture the transient events
- ▶ Ability to capture and store peak acceleration values of events
- ▶ Adjustable, low g threshold activity and inactivity detection
- ▶ Wide supply range: 1.6 V to 3.5 V
- Acceleration sample synchronization via external trigger
- ▶ SPI digital interface and limited I²C interface format support
- ▶ 12-bit output at 100 mg/LSB scale factor
- ▶ Wide temperature range: -40°C to +105°C
- ▶ Small, thin, 3 mm × 3.25 mm × 1.06 mm package

APPLICATIONS

- Impact and shock detection
- Asset health assessment
- Portable Internet of Things (IoT) edge nodes
- ▶ Concussion and head trauma detection

GENERAL DESCRIPTION

The ADXL372 is an ultralow power, 3-axis, $\pm 200~g$ MEMS accelerometer that consumes 22 μ A at a 3200 Hz output data rate (ODR). The ADXL372 does not power cycle its front end to achieve its low power operation and therefore does not run the risk of aliasing the output of the sensor.

In addition to its ultralow power consumption, the ADXL372 has many features to enable impact detection while providing system level power reduction. The device includes a deep multimode output first in, first out (FIFO), several activity detection modes, and a method for capturing only the peak acceleration of over threshold events.

Two additional lower power modes with interrupt driven, wake-up features are available for monitoring motion during periods of inactivity. In wake-up mode, acceleration data can be averaged to obtain a low enough output noise to trigger on low g thresholds. In instant on mode, the ADXL372 consumes 1.4 μ A while continuously monitoring the environment for impacts. When an impact event that exceeds the internally set threshold is detected, the device switches to normal operating mode fast enough to record the event.

High *g* applications tend to experience acceleration content over a wide range of frequencies. The ADXL372 includes a 4-pole low-pass antialiasing filter to attenuate out of band signals that are common in high *g* applications. The ADXL372 also incorporates a high-pass filter to eliminate initial and slow changing errors, such as ambient temperature drift.

The ADXL372 provides 12-bit output data at 100 mg/LSB scale factor. The user can access configuration and data registers via the serial peripheral interface (SPI) or limited I^2C protocol. The ADXL372 operates over a wide supply voltage range and is available in a 3 mm \times 3.25 mm \times 1.06 mm package.

Multifunction pin names may be referenced by their relevant function only.

FUNCTIONAL BLOCK DIAGRAM

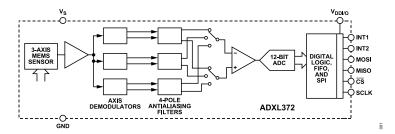


Figure 1.

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9/2022—Rev. B to Rev. C		
Added SPI Specifications Section		
Moved Table 2		
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Moved SPI Timing Diagrams Section and Figure 2 to F		
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Moved I ² C Timing Diagrams Section and Figure 7 to F	•	
Changes to Instant On Impact Detection Section		
Changes to Capturing Impact Events Section		
Changes to Figure 44		
Added Figure 45; Renumbered Sequentially		
Added Limitations Section		
Changes to Figure 47		
Changes to SPI Protocol Section		
Changes to Figure 100 and Table 67		
Added Silicon Anomaly Section		
Added ADXL372 Functionality Issues Section and Tab		
Added Functionality Issues Section, Table 72, Figure 1	I12, and Table 73; Renumbered Sequentially	
Added Figure 113 Table 74 and Table 75		50

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SPECIFICATIONS

 T_A = 25°C, V_S = 2.5 V, $V_{DDI/O}$ = 2.5 V, 3200 Hz ODR, 1600 Hz bandwidth, acceleration = 0 g, default register settings, unless otherwise noted. All minimum and maximum specifications are guaranteed. Typical specifications may not be guaranteed.

Table 1.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
SENSOR INPUT	Each axis				
Measurement Range			±200		g
Nonlinearity	Percentage of full scale		±0.5		%
Sensor Resonant Frequency			16		kHz
Cross Axis Sensitivity ¹			±2.5		%
OUTPUT RESOLUTION	Each axis				
All Operating Modes			12		Bits
SCALE FACTOR	Each axis				
Scale Factor Calibration Error				±10	%
Scale Factor at X _{OUT} , Y _{OUT} , Z _{OUT}	Expressed in mg/LSB		100		mg/LSB
	Expressed in LSB/g		10		LSB/g
Scale Factor Change Due to Temperature ²			0.1		%/°C
0 g OFFSET	Each axis				
0 g Output	X _{OUT} , Y _{OUT} , Z _{OUT}				
	At V _S = 2.5 V	-3	±1	+3	g
	$1.6 \text{ V} \le \text{V}_{\text{S}} \le 3.5 \text{ V}$	-7	±1	+7	g
0 g Offset vs. Temperature ²					
Normal Operation	X _{OUT} , Y _{OUT} , Z _{OUT}		±50		mg/°C
Low Noise Mode	X _{OUT} , Y _{OUT} , Z _{OUT}		±35		mg/°C
NOISE PERFORMANCE					
RMS Noise	Each axis				
Normal Operation			3.5		LSB
Low Noise Mode			3		LSB
BANDWIDTH	User selectable				
ODR		400		6400	Hz
High-Pass Filter, −3 dB Corner ³		0.24		30.48	Hz
Low-Pass (Antialiasing) Filter, −3 dB Corner ⁴	4-pole low-pass filter	200		ODR/2	Hz
POWER SUPPLY					
Operating Voltage Range (V _S)		1.6	2.5	3.5	V
Input/Output Voltage Range (V _{DDI/O})		1.6	2.5	V_S	V
Supply Current				· ·	
Measurement Mode	3200 Hz ODR				
Normal Operation			22		μA
Low Noise Mode			33		μA
Instant On Mode			1.4		μA
Wake-Up Mode	Varies with wake-up rate				'
•	At slowest wake-up rate		0.77		μA
Standby	· ·		<0.1		μA
Power Supply Rejection Ratio (PSRR)	C_S = 1.1 μ F, C_{IO} = 1.1 μ F, input is 100 sine wave on V_S	mV			
Input Frequency					
100 Hz to 1 kHz			-20		dB
1 kHz to 250 kHz			-17		dB
Turn-On Time	3200 Hz ODR				
Power-Up to Standby	$C_S = 1.1 \mu F, C_{IO} = 1.1 \mu F$		5		ms
Measurement Mode Instruction to Valid Data	Filter settle bit = 1		16		ms

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Table 1.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
	Filter settle bit = 0		370		ms
Instant On ULP Monitoring to Full Bandwidth Data			1		ms
ENVIRONMENTAL TEMPERATURE					
Operating Temperature Range		-40		+105	°C

¹ Cross axis sensitivity is defined as coupling between any two axes.

SPI SPECIFICATIONS

 T_A = 25°C, V_S = 2.5 V, $V_{DDI/O}$ = 2.5 V, unless otherwise noted.

Table 2. SPI Logic Levels and Timing

Parameter	Description	Min	Тур	Max	Unit
INPUT DC LEVELS					
V_{IL}	Low level input voltage			$0.3 \times V_{DDI/O}$	V
V_{IH}	High level input voltage	$0.7 \times V_{DDI/O}$			V
I _{IL}	Low level input current, V _{IN} = 0 V	-0.1			μA
I _{IH}	High level input current, V _{IN} = V _{DDI/O}			0.1	μA
OUTPUT DC LEVELS					
V_{OL}	Low level output voltage, I _{OL} = I _{OL, MIN}			$0.2 \times V_{DDI/O}$	V
V_{OH}	High level output voltage, $I_{OL} = I_{OH, MAX}$	0.8 × V _{DDI/O}			V
I _{OL}	Low level output current, V _{OL} = V _{OL, MAX}	-10			mA
I _{OH}	High level output current, V _{OL} = V _{OH, MIN}			4	mA
NPUT AC					
SCLK Frequency		0.1		10	MHz
t _{HIGH}	SCLK high time	40			ns
t_{LOW}	SCLK low time	40			ns
t _{CSS}	CS setup time	20			ns
t _{CSH}	CS hold time	20			ns
t_{CSD}	CS disable time	40			ns
t _{SCLKS}	Rising SCLK setup time	20			ns
t _{SU}	MOSI setup time	20			ns
t_{HD}	MOSI hold time	20			ns
OUTPUT AC					
t _P	Propagation delay, C _{LOAD} = 30 pF			30	ns
t_{EN}	Enable MISO time	30			ns
t _{DIS}	Disable MISO time			20	ns

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 $^{^2}$ -40°C to +25°C or +25°C to +105°C.

 $^{^{\,3}\,\,}$ This parameter has an available corner frequency scale with the ODR setting.

⁴ Bandwidth and ODR are set independent of each other.

SPECIFICATIONS

SPI Timing Diagrams

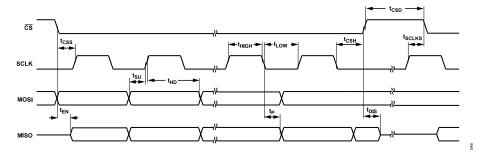


Figure 2. SPI Timing Diagram

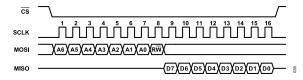


Figure 3. SPI Timing Diagram, Single Byte Read

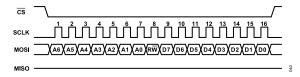


Figure 4. SPI Timing Diagram, Single Byte Write

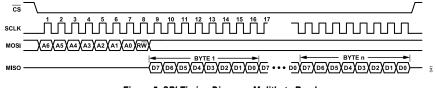


Figure 5. SPI Timing Diagram, Mulitbyte Read

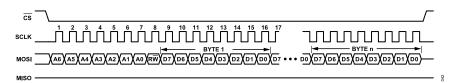


Figure 6. SPI Timing Diagram, Multibyte Write

I²C SPECIFICATIONS

 T_A = 25°C, V_S = 2.5 V, $V_{DDI/O}$ = 1.8 V, unless otherwise noted.

Table 3. I²C Logic Level and Timing

			I2C_HSM_EN = 0			I2C_HSM_I	EN = 1	
Parameter	Description	Min	Тур	Max	Min	Тур	Max	Unit
INPUT AC								
SCLK Frequency		0		1	0		3.4	MHz
t _{HIGH}	SCLK high time	260			120			ns

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Table 3. I²C Logic Level and Timing

		I2C_H	SM_EN = 0			I2C_HSM_I	EN = 1	
Parameter	Description	Min	Тур	Max	Min	Тур	Max	Unit
t _{LOW}	SCLK low time	500			320			ns
t _{SUSTA}	Start setup time	260			160			ns
t _{HDSTA}	Start hold time	260			160			ns
t _{SUDAT}	Data setup time	50			10			ns
t_{HDDAT}	Data hold time	0			0		150	ns
t _{susto}	Stop setup time	260			160			ns
t_{BUF}	Bus free time	500						ns
t_{RCL}	SCL input rise time			120	20		80	ns
$t_{\sf FCL}$	SCL input fall time	20 × (V _{DD} /5.5)		120	20		80	ns
t_{RDA}	SDA input rise time			120	20		160	ns
$t_{\sf FDA}$	SDA input fall time	20 × (V _{DD} /5.5)		120	20		160	ns
OUTPUT AC								
C_{LOAD}				550			400	pF

I²C Timing Diagrams

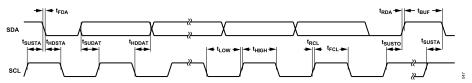


Figure 7. I²C Timing Diagram

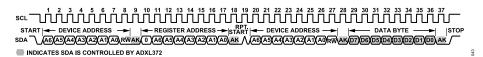


Figure 8. I²C Timing Diagram, Single Byte Read



Figure 9. I²C Timing Diagram, Single Byte Write



Figure 10. I²C Timing Diagram, Multibyte Write

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ABSOLUTE MAXIMUM RATINGS

Table 4.

Parameter	Rating
Acceleration	
Any Axis, Unpowered	10000 g
Any Axis, Powered	10000 g
V_S	-0.3 V to +3.6 V
$V_{\rm DDI/O}$	-0.3 V to +3.6 V
All Other Pins	-0.3 V to V _S
Output Short-Circuit Duration (Any Pin to Ground)	Indefinite
ESD, Human Body Model (HBM)	2000 V
Temperature Range (Storage)	-50°C to +150°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

Table 5.

Package Type ¹	θ_{JA}	θ_{JC}	Unit	Device Weight
CC-16-4	150	85	°C/W	18 mg

¹ Thermal impedance simulated values are based on a JEDEC 2S2P thermal test board with four thermal vias. See JEDEC JESD51.

RECOMMENDED SOLDERING PROFILE

Figure 11 and Table 6 provide details about the recommended soldering profile.

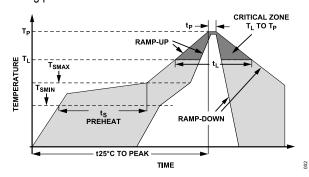


Figure 11. Recommended Soldering Profile

Table 6. Recommended Soldering Profile

	Condition			
Profile Feature	Sn63/Pb37	Pb-Free		
Average Ramp Rate (T _L to T _P)	3°C/sec max	3°C/sec max		
Preheat				
Minimum Temperature (T _{SMIN})	100°C	150°C		
Maximum Temperature (T _{SMAX})	150°C	200°C		
Time $(T_{SMIN} \text{ to } T_{SMAX}) (t_S)$	60 sec to	60 sec to		
	120 sec	180 sec		
T _{SMAX} to T _L				
Ramp-Up Rate	3°C/sec max	3°C/sec max		
Time Maintained Above Liquidous (T _L)				
Liquidous Temperature (T _L)	183°C	217°C		
Time (t _L)	60 sec to	60 sec to		
	150 sec	150 sec		
Peak Temperature (T _P)	240 + 0/-5°C	260 + 0/-5°C		
Time Within 5°C of Actual Peak	10 sec to 30 sec	20 sec to 40 sec		
Temperature (t _P)				
Ramp-Down Rate	6°C/sec max	6°C/sec max		
Time 25°C to Peak Temperature	6 minutes max	8 minutes max		

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

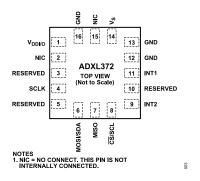


Figure 12. Pin Configuration (Top View)

Table 7. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V _{DDI/O}	Supply Voltage for Digital Input/Output.
2	NIC	No Connect. This pin is not internally connected.
3	RESERVED	Reserved. This pin may be left unconnected or connected to GND.
4	SCLK	SPI Serial Communications Clock.
5	RESERVED	Reserved. This pin may be left unconnected or connected to GND.
6	MOSI/SDA	SPI Master Output, Slave Input (MOSI). I ² C Serial Data (SDA).
7	MISO	SPI Master Input, Slave Output.
8	CS/SCL	SPI Chip Select (CS). I ² C Serial Communications Clock (SCL).
9	INT2	Interrupt 2 Output. This pin also serves as an input for synchronized sampling.
10	RESERVED	Reserved. This pin may be left unconnected or connected to GND.
11	INT1	Interrupt 1 Output. This pin also serves as an input for external clocking.
12	GND	Ground. This pin must be connected to ground.
13	GND	Ground. This pin must be connected to ground.
14	V _S	Supply Voltage.
15	NIC	No Connect. This pin is not internally connected.
16	GND	Ground. This pin must be connected to ground.

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TYPICAL PERFORMANCE CHARACTERISTICS

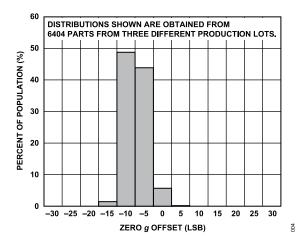


Figure 13. X-Axis Zero g Offset at 25°C, V_S = 2.5 V

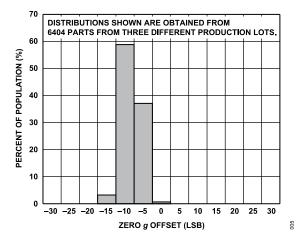


Figure 14. Y-Axis Zero g Offset at 25°C, V_S = 2.5 V

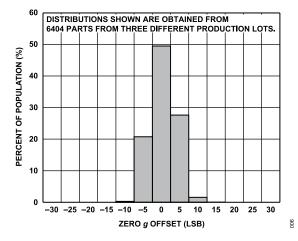


Figure 15. Z-Axis Zero g Offset at 25°C, $V_S = 2.5 \text{ V}$

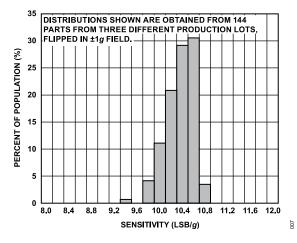


Figure 16. X-Axis Sensitivity at 25°C, V_S = 2.5 V

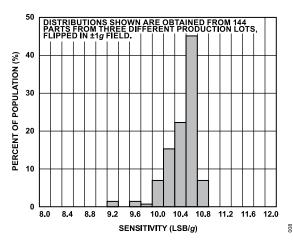


Figure 17. Y-Axis Sensitivity at 25°C, V_S = 2.5 V

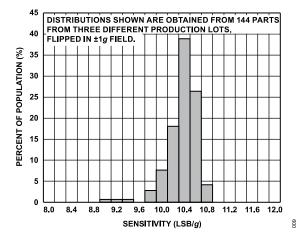


Figure 18. Z-Axis Sensitivity at 25°C, $V_S = 2.5 \text{ V}$

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TYPICAL PERFORMANCE CHARACTERISTICS

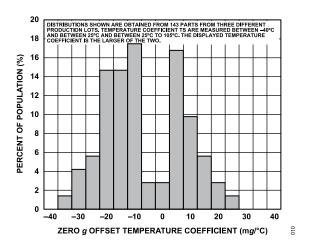


Figure 19. X-Axis Zero g Offset Temperature Coefficient, V_S = 2.5 V

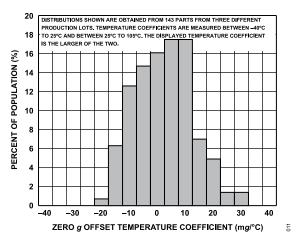


Figure 20. Y-Axis Zero g Offset Temperature Coefficient, V_S = 2.5 V

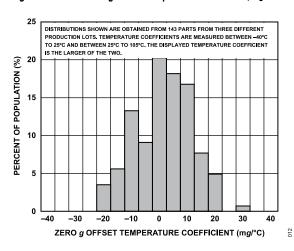


Figure 21. Z-Axis Zero g Offset Temperature Coefficient, $V_S = 2.5 \text{ V}$

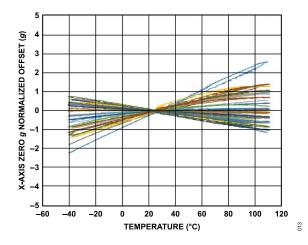


Figure 22. X-Axis Zero g Normalized Offset vs. Temperature, 36 Parts Soldered to PCB, ODR = 3200 Hz

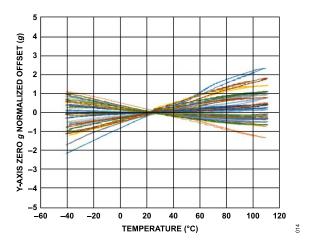


Figure 23. Y-Axis Zero g Normalized Offset vs. Temperature, 36 Parts Soldered to PCB, ODR = 3200 Hz

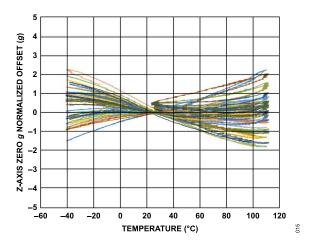


Figure 24. Z-Axis Zero g Normalized Offset vs. Temperature, 36 Parts Soldered to PCB, ODR = 3200 Hz

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TYPICAL PERFORMANCE CHARACTERISTICS

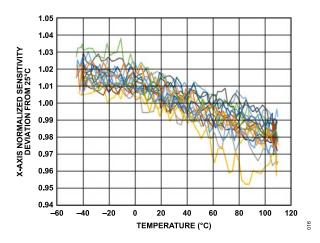


Figure 25. X-Axis Normalized Sensitivity Deviation from 25°C vs. Temperature, 18 Parts Soldered to PCB, ODR = 3200 Hz

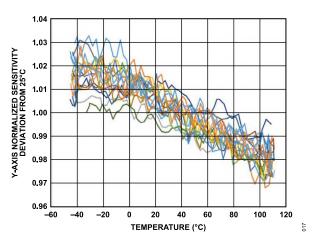


Figure 26. Y-Axis Normalized Sensitivity Deviation from 25°C vs. Temperature, 17 Parts Soldered to PCB, ODR = 3200 Hz

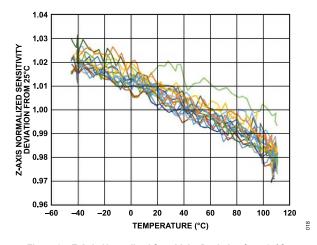


Figure 27. Z-Axis Normalized Sensitivity Deviation from 25°C vs. Temperature, 18 Parts Soldered to PCB, ODR = 3200 Hz

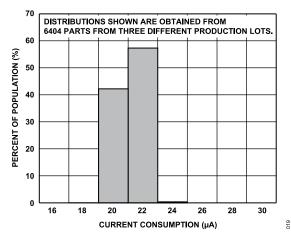


Figure 28. Current Consumption at 25°C, Normal Mode, 3200 Hz Output Data Rate, V_S = 2.5 V

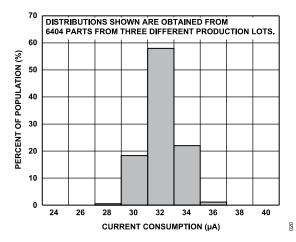


Figure 29. Current Consumption at 25°C, Low Noise Mode, 3200 Hz Output Data Rate, V_S = 2.5 V

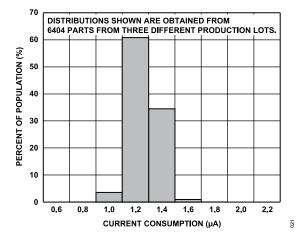


Figure 30. Current Consumption at 25°C, Instant On Mode, $V_S = 2.5 \text{ V}$

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TYPICAL PERFORMANCE CHARACTERISTICS

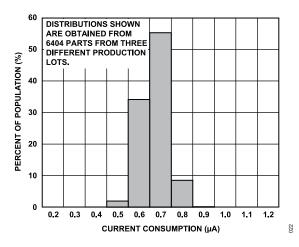


Figure 31. Current Consumption at 25°C, Wake-Up Mode, V_S = 2.5 V

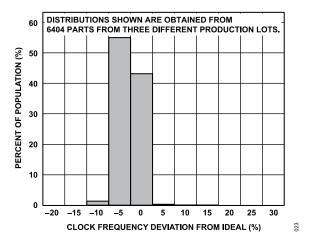


Figure 32. Clock Frequency Deviation from Ideal at 25°C, ODR = 3200 Hz, V_S = 2.5 V

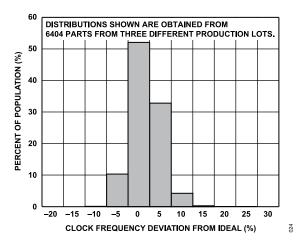


Figure 33. Clock Frequency Deviation from Ideal at 25°C, ODR = 6400Hz, V_S = 2.5 V

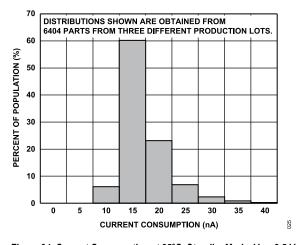


Figure 34. Current Consumption at 25°C, Standby Mode, V_S = 2.5 V

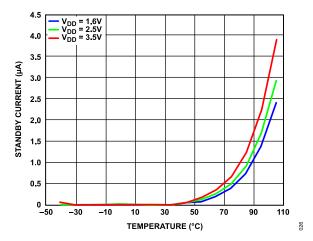


Figure 35. Standby Current vs. Temperature

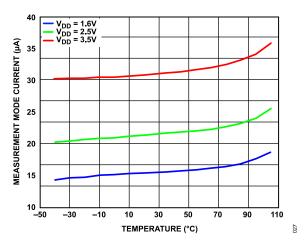


Figure 36. Measurement Mode Current vs. Temperature

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TYPICAL PERFORMANCE CHARACTERISTICS

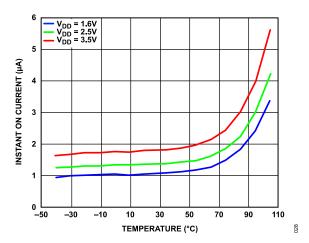


Figure 37. Instant On Current vs. Temperature

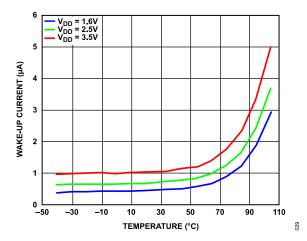


Figure 38. Wake-Up Current vs. Temperature

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THEORY OF OPERATION

The ADXL372 is a complete 3-axis acceleration measurement system that operates at extremely low power levels. Acceleration is reported digitally, and the device communicates via the SPI and I²C protocols. Built in digital logic enables autonomous operation and implements functions that enhance system level power savings.

MECHANICAL DEVICE OPERATION

The moving component of the sensor is a polysilicon surface micromachined structure built on top of a silicon wafer. Polysilicon springs suspend the structure over the surface of the wafer and provide a resistance against acceleration forces.

Deflection of the structure is measured using differential capacitors that consist of independent fixed plates and plates attached to the moving mass. Acceleration deflects the structure and unbalances the differential capacitor, resulting in a sensor output whose amplitude is proportional to acceleration. Phase sensitive demodulation determines the magnitude and polarity of the acceleration.

OPERATING MODES

The ADXL372 has three operating modes: measurement mode for continuous, wide bandwidth sensing; an instant on mode for low power impact detection; and wake-up mode for limited bandwidth low *g* activity detection. Measurement can be suspended by placing the device in standby mode.

Measurement Mode

Measurement mode is the default operating mode of the ADXL372. In this mode, acceleration data is read continuously, and the accelerometer consumes 22 μA (typical) at an ODR of 3200 Hz using a 2.5 V supply. Actual current consumption is dependent on the ODR chosen. All features described in this data sheet are available when operating the ADXL372 in this mode.

Instant On Mode

Instant on mode enables extremely low power impact detection. In this mode, the accelerometer constantly monitors the environment while consuming a very low current of 1.4 μ A (typical). When an event that exceeds an internal threshold is detected, the device switches into measurement mode to record the event. The target default threshold is 10 g ±5 g. A register option allows the threshold to be increased to a target of 30 g ±10 g if the default threshold is too low.

To save power, no new digital acceleration data is made available until the accelerometer switches into normal operation. However, all registers have normal read/write functionality.

Wake-Up Mode

Wake-up mode is ideal for simple detection of the presence or absence of motion at an extremely low power consumption. Wake-up mode is particularly useful for the implementation of a low g

motion activated on/off switch, allowing the rest of the system to be powered down until sustained activity is detected.

In wake-up mode, the device is powered down for a duration of time equal to the wake-up timer, set by the WAKEUP_RATE bits in the TIMING register, and then turns on for a duration equal to the filter settling time (see the Filter Settling Time section). The current drawn in this mode is determined by both these parameters.

Table 8. Wake-Up Current in μA at Different Wake-Up Timer and Filter Settings

	Filte	er Settling Time
Wake-Up Timer (ms)	16 ms	370 ms
52	5.8 µA	19.4 µA
104	3.6 µA	17.3 µA
208	2.3 µA	14.4 µA
512	1.4 µA	9.7 µA
2048	0.91 μΑ	4 μΑ
4096	0.83 μΑ	2.5 µA
8192	0.79 μΑ	1.7 µA
24576	0.77 μΑ	1.1 µA

If motion is detected, the accelerometer can respond autonomously in several ways, depending on the device configuration, such as the following:

- ▶ Switch into full bandwidth measurement mode.
- Signal an interrupt to a microcontroller.
- Wake up downstream circuitry.

While in wake-up mode, all registers and the FIFO have normal read/write functionality, and real-time data can be read from the data registers at the reduced wake-up rate. However, no new data is stored in the FIFO during wake-up mode, and there are no interrupts available in wake-up mode.

Standby

Placing the ADXL372 in standby mode suspends measurement and reduces current consumption to less than 100 nA. All interrupts are cleared, and no new interrupts are generated. The ADXL372 powers up in standby mode with all sensor functions turned off.

BANDWIDTH

Low-Pass Antialiasing Filter

High *g* events often include acceleration content over a wide range of frequencies. The analog-to-digital converter (ADC) of the ADXL372 samples the input acceleration at the user selected ODR. In the absence of antialiasing filters, input signals whose frequency is more than half the ODR alias or that fold into the measurement bandwidth can lead to inaccurate measurements. To mitigate this inaccuracy, a four-pole, low-pass filter is provided at the input of the ADC. The filter bandwidth is user selectable, and the default bandwidth is 200 Hz. The maximum bandwidth is constrained to

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THEORY OF OPERATION

at most half of the ODR, to ensure that the Nyquist criteria is not violated.

High-Pass Filter

The ADXL372 offers a one-pole, high-pass filter with a user selectable –3 dB frequency. Applications that do not require dc acceleration measurements can use the high-pass filter to minimize constant or slow varying offset errors including initial bias, bias drift due to temperature, and bias drift due to supply voltage.

The high-pass filter is a first-order infinite impulse response (IIR) filter. Table 9 lists the available –3 dB frequencies, which are user selectable and dependent on the output data rate. The high-pass and low-pass filters can be used simultaneously to set up a bandpass option.

Table 9. High-Pass Filter -3 dB Corner Frequencies

		ODR (Hz)					
Setting	6400	3200	1600	800	400		
00	30.48	15.24	7.61	3.81	1.9		
01	15.58	7.79	3.89	1.94	0.97		
10	7.88	3.94	1.97	0.98	0.49		
11	3.96	1.98	0.99	0.49	0.24		

Filter Settling Time

After entering measurement mode, the first output value does not appear until after the filter settling time has passed. This time is selectable using the FILTER_SETTLE bit in the POWER_CTL register. The recommended (and default) settling time to acquire valid data when using either the high-pass filter or the low-pass activity detect filter is 370 ms. The filter settling time of 16 ms is ideal for when both the high-pass filter and low-pass activity detect filter are disabled.

Selectable ODR

The ADXL372 can report acceleration data at 400 Hz, 800 Hz, 1600 Hz, 3200 Hz, or 6400 Hz. The ODR is user selectable and the default is 400 Hz. In the event that the user selects an anti-aliasing

Table 10. Noise and Current Consumption for $V_S = 2.5 \text{ V}$

Table 10. Noise and Current Consumption for VS - 2.5 V		
Mode	Typical RMS Noise (LSB)	Typical Current Consumption (μA)
Normal Operation ¹	3.5	22
Low Noise ¹	3	33

 $^{^{1}}$ V_S = 2.5 V, ODR = 3200 Hz, and bandwidth = 1600 Hz.

Table 11. Noise and Current Consumption for $V_S = 3.5 \text{ V}$

Mode	Typical RMS Noise (LSB)	Typical Current Consumption (μA)
Normal Operation ¹	3	32
Low Noise ¹	2.5	44

 $^{^{1}}$ V_S = 3.5 V, ODR = 3200 Hz, and bandwidth = 1600 Hz.

filter bandwidth greater than half the ODR, the device defaults the bandwidth to half the ODR. Increasing or decreasing the ODR increases or decreases the current consumption accordingly, as shown in Figure 39.

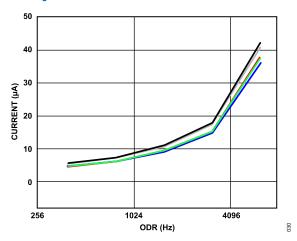


Figure 39. Measurement Mode Current vs. ODR for Five Parts

POWER/NOISE TRADE-OFF

The noise performance of the ADXL372 in normal operation, typically 3.5 LSB rms at 3200 Hz ODR and 1600 Hz bandwidth, is adequate for most applications, depending on bandwidth and the desired resolution. For cases where lower noise is needed, the ADXL372 provides a lower noise operating mode that trades reduced noise for a somewhat higher current consumption. In all cases, operating at a higher bandwidth setting increases the rms noise and operating with a lower bandwidth decreases the noise. Table 10 lists the current consumption and noise densities obtained for normal operation and the lower noise mode at a typical 2.5 V supply.

Operating the ADXL372 at a higher supply voltage also decreases noise. Table 11 lists the current consumption and noise densities obtained for normal operation and the lower noise mode at the highest recommended supply, 3.5 V.

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POWER SAVINGS

The digital interface of the ADXL372 is implemented with system level power savings in mind. The following features enhance power savings:

- ▶ Burst reads and writes reduce the number of SPI communication cycles required to configure the device and retrieve data.
- ➤ Concurrent operation of activity and inactivity detection enables set it and forget it operation. Loop modes further reduce communications power by enabling the clearing of interrupts without processor intervention.
- ▶ The FIFO is implemented such that consecutive samples can be read continuously via a multibyte read of unlimited length; thus, one FIFO read instruction can clear the entire contents of the FIFO. The ADXL372 FIFO construction also allows the use of direct memory access (DMA) to read the FIFO contents.

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AUTONOMOUS EVENT DETECTION

ACTIVITY AND INACTIVITY

The ADXL372 features built in logic that detects activity (defined as acceleration above a user set threshold) and inactivity (defined as acceleration below a user set threshold). Activity and inactivity events can be used as triggers to manage the accelerometer operating mode, trigger an interrupt to a host processor, and/or autonomously drive a motion switch.

Detection of an activity or inactivity event is indicated in the STA-TUS2 register and can be configured to generate an interrupt. In addition, the activity status of the device, that is, whether it is moving or stationary, is indicated by the AWAKE bit, described in the Using the AWAKE Bit section.

Activity and inactivity detection can be used when the accelerometer is in either measurement mode or wake-up mode. However, the activity and inactivity interrupts are not available in wake-up mode because the device is inherently looking for activity in this mode, and any changes to activity or inactivity detection features must be made while the device is in standby mode.

Low-Pass Activity Detect Filter

The ADXL372 combines high g impact detection and low g movement detection in one device. For low g detection, an internal low-pass filter with a -3 dB corner of approximately 10 Hz averages data to reduce the rms noise, allowing accurate detection of activity or inactivity thresholds as low as 500 mg. For high g impact detection, the low-pass activity detect filter can be turned off through a register setting. When using both the low-pass activity detect filter and the high-pass filter, the user must select a high-pass filter corner that does not exceed 10 Hz; otherwise, activity detection data is severely attenuated.

Activity Detection

An activity event is detected when acceleration in at least one enabled axis remains above a specified threshold for a specified time. Enabled axes, thresholds, and time are user selected. Each axis has its own activity threshold, but the activity timer is shared among all three axes. When multiple axes are selected, an over-threshold event on any one enabled axis triggers the activity detection.

Referenced and Absolute Configurations

Activity detection can be configured as referenced or absolute mode for all axes through the ACT_REF bit in the THRESH_ ACT_X_L register.

When using absolute activity detection, acceleration samples are compared directly to a user set threshold to determine whether motion is present. For example, if a threshold of $0.5\ g$ is set and the acceleration on the z-axis is $1\ g$ longer than the user defined activity time, the activity status asserts.

In many applications, it is advantageous for activity detection to be based not on an absolute threshold, but on a deviation from

a reference point or orientation. The referenced activity detection is particularly useful because it removes the effect on activity detection of the static 1 g imposed by gravity as well as any static offset errors, which can be up to several g. In absolute activity detection, when the threshold is set to less than 1 g, activity is immediately detected in this case.

In the referenced configuration, activity is detected when acceleration samples are above an internally defined reference by a user defined amount for the user defined amount of time, as described by

Abs(Acceleration - Reference) > Threshold

where Abs is the absolute value.

Consequently, activity is detected only when the acceleration has deviated sufficiently from the initial orientation. The default setting for the accelerometer is in absolute mode. After it is placed in referenced mode through the appropriate register setting, the reference for activity detection is calculated as soon as full bandwidth measurement mode is turned on. To reset the reference, it is necessary to put the device back into absolute mode and then back to referenced mode. The new reference is set as soon as the device enters full bandwidth measurement mode again. If using both activity and inactivity detection in referenced mode, both must be set back to absolute mode before the reference can be reset.

Activity Timer

Ideally, the intent of activity detection is to wake up a system only when motion is intentional, ignoring noise or small, unintentional movements. In addition to being sensitive to low g events, the ADXL372 activity detection algorithm is robust in filtering out undesired triggers.

The ADXL372 activity detection functionality includes a timer to filter out unwanted motion and ensure that only sustained motion is recognized as activity. The timer period depends on the ODR selected. At 3200 Hz and below, it is ~6.6 ms; at 6400 Hz, it is ~3.3 ms. For activity detection to trigger, above threshold activity must be sustained for a time equal to the number of activity timer periods specified in the activity time register. For example, a setting of 10 in this register means that above threshold activity must be sustained for 66 ms at 3200 Hz ODR. A register value of zero results in single sample activity detection. The maximum allowable activity time is ~1.68 sec (or 841.5 ms at 6400 Hz ODR). Note that the activity timer is operational in measurement mode only.

Activity Detection in Wake-Up Mode

If activity detection is enabled while the device is in wake-up mode, the device uses single sample activity detection, no matter the activity time register setting. If activity is detected, the device automatically returns to full bandwidth measurement mode. However, the activity interrupt is not generated unless the activity time setting is zero. If it is not zero, after entering measurement mode, the

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AUTONOMOUS EVENT DETECTION

interrupt is not generated until the device sees sustained activity for the amount of time given in the activity time register. The awake interrupt automatically goes high upon entering measurement mode if the device is in default mode or autosleep mode. If it is in linked or loop mode (but not autosleep), it is linked to the activity interrupt, which behaves as previously mentioned.

After the device automatically enters measurement mode due to activity detection, if autosleep is not on, it must be placed manually back into wake-up mode.

Inactivity Detection

An inactivity event is detected when acceleration in all enabled axes remains below a specified threshold for a specified time. Enabled axes, threshold, and time are user selected. Each axis has its own inactivity threshold, but the inactivity timer is shared among all three axes. When multiple axes are selected, all enabled axes must stay under the threshold for the required amount of time to trigger inactivity detection.

Referenced and Absolute Configurations

Inactivity detection is also configurable as referenced or absolute through the INACT_REF bit in the THRESH_INACT_X_L register. When using absolute inactivity detection, acceleration samples are compared directly to a user set threshold for the user set time to determine the absence of motion. Inactivity is detected when enough consecutive samples are all below the threshold.

When using referenced inactivity detection, inactivity is detected when acceleration samples are within a user specified amount from an internally defined reference for a user defined amount of time.

Abs(Acceleration - Reference) < Threshold

Referenced inactivity, like referenced activity, is particularly useful for eliminating the effects of the static acceleration due to gravity, as well as other static offsets. With absolute inactivity, if the inactivity threshold is set lower than 1 g, a device resting motionless may never detect inactivity. With referenced inactivity, the same device under the same configuration detects inactivity. The default setting for the accelerometer is in absolute mode. After it is placed in referenced mode through the appropriate register setting, the reference for inactivity detection is calculated as soon as full bandwidth measurement mode is turned on. To reset the reference, it is necessary to put the device back into absolute mode and then back to referenced mode. The new reference is set as soon as the device enters full bandwidth measurement mode again. If using both inactivity and activity detection in referenced mode, both must be set back to absolute mode before the reference can be reset.

Inactivity Timer

The ADXL372 inactivity detect functionality includes a timer to allow detection of sustained inactivity. The timer period depends on the ODR selected. At 3200 Hz and below, it is ~26 ms; at 6400 Hz, it is

~13 ms. For inactivity detection to trigger, below threshold inactivity must be sustained for a time equal to the number of inactivity timer periods specified in the inactivity time registers. For example, a setting of 10 in these registers means that below threshold inactivity must be sustained for 260 ms at 3200 Hz ODR. A value of zero in these registers results in single sample, inactivity detection. The maximum allowable inactivity time is ~28.4 minutes at 3200 Hz ODR (or ~14.2 minutes at 6400 Hz ODR).

Linking Activity and Inactivity Detection

When in measurement mode or wake-up mode, the activity and inactivity detection functions can be used concurrently and processed manually by a host processor, or they can be configured to interact in several other ways, such as those that follow.

Default Mode

In default mode, activity and inactivity detection are both available simultaneously, and all interrupts must be serviced by a host processor; that is, a processor must read each interrupt before it is cleared and can be used again. Refer to the Interrupts section for information on clearing interrupts.

The flowchart in Figure 40 illustrates default mode operation.

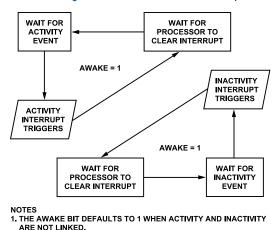


Figure 40. Flowchart Illustrating Activity and Inactivity Operation in Default

Mode

Linked Mode

In linked mode, activity and inactivity detection are linked to each other such that only one of the functions is enabled at any given time. As soon as activity is detected, the device is assumed to be moving (or awake) and stops looking for activity; rather, inactivity is expected as the next event. Therefore, only inactivity detection operates.

Similarly, when inactivity is detected, the device is assumed to be stationary (or asleep). Thus, activity is expected as the next event; therefore, only activity detection operates.

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AUTONOMOUS EVENT DETECTION

In linked mode, each interrupt must be serviced by a host processor before the next interrupt is enabled.

The flowchart in Figure 41 illustrates linked mode operation.

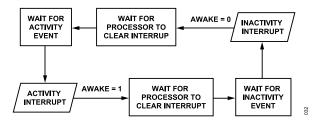


Figure 41. Flowchart Illustrating Activity and Inactivity Operation in Linked

Loop Mode

In loop mode, motion detection operates as described in the Linked Mode section, but interrupts do not need to be serviced by a host processor. This configuration simplifies the implementation of commonly used motion detection and enhances power savings by reducing the amount of power used in bus communication.

The flowchart in Figure 42 illustrates loop mode operation.

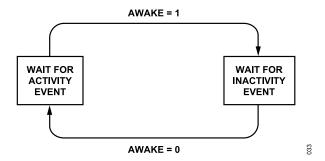


Figure 42. Flowchart Illustrating Activity and Inactivity Operation in Loop

Mode

Autosleep

If autosleep is selected, after the device is placed in wake-up mode (see the Wake-Up Mode section), it automatically sets to loop mode and begins looking for activity. When activity is detected, the device automatically enters measurement mode and immediately begins looking for inactivity. When inactivity is detected, the device automatically re-enters wake-up mode. Note that the device must be manually placed in wake-up mode before autosleep can begin functioning. It does not automatically enter wake-up mode if the device is started up manually in measurement mode.

Using the AWAKE Bit

The AWAKE bit is a status bit that indicates whether the ADXL372 is awake or asleep. In default mode or autosleep mode, the AWAKE bit is high whenever the device is in measurement mode. In linked or loop mode, the AWAKE bit is high whenever the device

experiences an activity condition, and it is low when the device experiences an inactivity condition.

The awake signal can be mapped to the INT1 or the INT2 pin allowing the pin to serve as a status output to connect or disconnect power to downstream circuitry based on the awake status of the accelerometer. Used in conjunction with loop mode, this configuration implements a simple, autonomous motion activated switch.

If the turn-on time of downstream circuitry can be tolerated, this motion switch configuration can save significant system level power by eliminating the standby current consumption of the remainder of the application circuit. This standby current can often exceed the full operating current of the ADXL372.

MOTION WARNING

In addition to the activity threshold previously described, the ADXL372 offers a secondary threshold. This second threshold, the motion warning threshold, can be set independently of the activity threshold. It does not have any functionality related to autosleep, linked, or loop mode, or the device awake status. The purpose of the motion warning functionality is to issue a notification to the system, via the status bit and/or interrupt, that the observed acceleration has exceeded the second threshold. It is controlled by the THRESH_ACT2_x_x registers, and by the ACTIVITY2 interrupt, which is sent only to the INT2 pin. Each axis has its own motion warning threshold. However, the motion warning activity interrupt does not have an activity timer. It is only used for single sample, activity detection. The motion warning threshold also shares the same referenced vs. absolute configuration as the primary activity detection.

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IMPACT DETECTION FEATURES

Impact detection applications often require high *g* and high bandwidth acceleration measurements, and the ADXL372 is designed with these applications in mind. Several features are included that target impact detection and aim to simplify the system design.

WIDE BANDWIDTH

An impact is a transient event that produces an acceleration pulse with frequency content over a wide range. A sufficiently wide bandwidth is needed to capture the impact event because lowering bandwidth has the effect of reducing the magnitude of the recorded signal, resulting in measurement inaccuracy.

The ADXL372 can operate with bandwidths of up to 3200 Hz at extremely low power levels. A steep filter roll-off is also useful for effective suppression of out of band content, and the ADXL372 incorporates a four-pole, low-pass antialiasing filter for this purpose.

INSTANT ON IMPACT DETECTION

The ADXL372 instant on mode is an ultra low power mode that continuously monitors the environment for impact events that exceed a built in threshold. When an impact is detected, the device switches into full measurement mode and captures the impact profile.

The user must enter instant on mode from full bandwidth measurement mode. No digital data is available in this mode of operation. The user can set the instant on threshold to either low (10 $g \pm 5$ g) or high (30 $g \pm 10$ g) by using the INSTANT_ON_ THRESH bit in the POWER_CTL register. When an impact beyond the selected threshold is detected, the ADXL372 switches to full bandwidth measurement mode and begins outputting digital data.

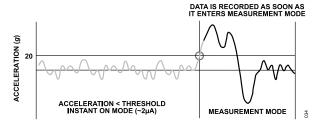


Figure 43. Instant On Mode Using Default Threshold

After the accelerometer is in full bandwidth measurement mode, it must be set back into instant on mode manually. It cannot return to instant on mode automatically.

CAPTURING IMPACT EVENTS

In certain applications, a single (3-axis) acceleration sample at the peak of an impact event contains sufficient information about the event, and the full acceleration history is not required. For these applications, the ADXL372 provides the capability to store only the peak acceleration of each impact event. The ADXL372 peak detection function considers an impact event as an acceleration signal that occurs within an activity interrupt and the next inactivity interrupt. The peak of an impact event is defined as the x, y, and z acceleration sample that has the highest magnitude of all

other values within an impact event, as shown in Figure 44. The magnitude of each sample set is calculated as $x^2 + y^2 + z^2$.

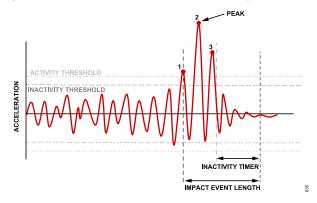


Figure 44. Capturing Impact Events

The peak detection feature stores the peak acceleration in the MAXPEAK_x_x registers (Register 0x15 to Register 0x1A). MAXPEAK_x_x registers are cleared when read. If MAXPEAK_x_x registers were not read after an impact event and another impact event with a higher peak occurs, the MAXPEAK_x_x registers are automatically updated with the higher peak acceleration values. On the contrary, if the next peak magnitude is lower than the current peak stored in the MAXPEAK_x_x registers, the MAXPEAK_x_x registers are not updated. In the example of Figure 45, if the MAXPEAK_x_x registers are read after Impact Event 4, their values correspond to the peak detected during Impact Event 3, which was the highest peak of all four impact events.

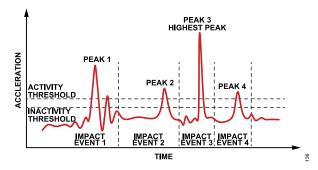


Figure 45. Capturing Highest Peak Within Multiple Impact Events

Follow these steps to enable peak detection:

- Configure the FIFO_CTL register for peak detect mode (b0011100X to Register 0x3A).
- 2. Set the desired activity threshold and time settings (Register 0x23 to Register 0x29).
- Set the desired inactivity threshold and time settings (Register 0x2A to Register 0x31).
- **4.** Set the activity mode to linked or loop mode (Register 0x3E).

The FIFO provides additional flexibility for the peak detection feature, allowing its use in applications that require keeping record of the peak of all impact events that occurred within a period of time,

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IMPACT DETECTION FEATURES

with minimal intervention from the host processor. To enable FIFO and peak detection, follow these steps:

- 1. Configure the FIFO_CTL register for peak detect mode and stream mode (b0011101X to Register 0x3A).
- Set the desired activity threshold and time settings (Register 0x23 to Register 0x29).
- Set the desired inactivity threshold and time settings (Register 0x2A to Register 0x31).
- **4.** Set the activity mode to linked or loop mode (Register 0x3E).

Always read acceleration data from MAXPEAK_x_x registers and from the FIFO memory using multibyte transfer to ensure a concurrent and complete set of x, y, and z acceleration data is read.

Limitations

The user must be aware that the ADXL372 cannot properly capture impact events of higher frequency than the user selected bandwidth. As a rule, the ADXL372 must be able to capture at least two samples from the moment the activity interrupt is triggered to the moment the peak acceleration occurs. If this requirement is not met, significantly lower acceleration values than the actual peak, or even zeros, may be stored in the MAXPEAK x x registers.

The peak detection function determines the peak of an event by comparing the sum square of each set of x, y, and z acceleration samples within an impact event. The sum square is performed internally using 7-bit multipliers, and because the acceleration data is 12-bit resolution, a maximum error of approximately $\pm 3~g$ can occur on the determination of the peak.

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FIFO

The ADXL372 includes a deep, 512-sample FIFO buffer.

BENEFITS OF THE FIFO

The FIFO buffer is an important feature in ultralow power applications in two ways: system level power savings and data recording/event context.

System Level Power Savings

Appropriate use of the FIFO enables system level power savings by enabling the host processor to sleep for extended periods while the accelerometer autonomously collects data. Alternatively, using the FIFO to collect data can unburden the host while it tends to other tasks

Data Recording/Event Context

The FIFO can be used in a triggered mode to record all data leading up to an activity detection event, thereby providing context for the event. In the case of a system that identifies impact events, for example, the accelerometer can keep the entire system off while it stores acceleration data in its FIFO and looks for an activity event. When the impact event occurs, data collected prior to the event is frozen in the FIFO. The accelerometer can now wake the rest of the system and transfer this data to the host processor, thereby providing context for the impact event.

Generally, the more context available, the more intelligent decisions a system can achieve, making a deep FIFO especially useful. For example, the ADXL372 FIFO can store up to 512 1-axis samples at 400 Hz ODR, providing a 1.28 sec window, or 170 3-axis samples at 3200 Hz to provide a 50 ms window, which is a typical duration for impact events.

USING THE FIFO

The FIFO is a 512-sample memory buffer that can save power, unburden the host processor, and autonomously record data.

FIFO operation is configured via Register 0x39 and Register 0x3A. The 512 FIFO samples can be allotted in several ways, such as the following:

- ▶ 170 sample sets of concurrent 3-axis data
- ▶ 256 sample sets of concurrent 2-axis data (user selectable)
- ▶ 512 sample sets of single-axis data
- ▶ 170 sets of impact event peak (x, y, z)

All FIFO modes must be configured while in standby mode. When reading data from multiple axes from the FIFO, to ensure that data is not overwritten and stored out of order, at least one sample set must be left in the FIFO after every read (therefore, a set of 3-axis data must have 169 samples at most).

The FIFO operates in one of the following four modes: FIFO disabled, oldest saved mode (first N), stream mode (last N), and triggered mode.

FIFO Disabled

When the FIFO is disabled, no new data is stored in it, and any data already in it is cleared.

The FIFO is disabled by setting the FIFO_MODE bits in the FIFO CTL register (Register 0x3A) to 0b00.

Oldest Saved Mode (First N)

In oldest saved mode, the FIFO accumulates data until it is full and then stops. After reading the data, the FIFO must be disabled and re-enabled to save a new set of data. One possible use case for this mode is to enable it right after entering instant on mode. After a shock is detected, the data immediately stores in the FIFO to be read whenever convenient.

The FIFO is placed into oldest saved mode by setting the FIFO MODE bits in the FIFO CTL register (Register 0x3A) to 0b11.

Stream Mode (Last N)

In stream mode, the FIFO always contains the most recent data. The oldest sample is discarded when space is needed to make room for a newer sample.

Stream mode is useful for unburdening a host processor. The processor can tend to other tasks while data is being collected in the FIFO. When the FIFO fills to a certain number of samples (specified by the FIFO_SAMPLES register along with Bit 0 in the FIFO_CTL register), it triggers a watermark interrupt (if this interrupt is enabled). At this point, the host processor can read the contents of the entire FIFO and then return to its other tasks as the FIFO fills again.

The FIFO is placed into stream mode by setting the FIFO_MODE bits in the FIFO_CTL register (Register 0x3A) to 0b01.

Triggered Mode

In triggered mode, the FIFO operates as in stream mode until an activity detection event, after which it saves the samples surrounding that event. The operation is similar to a one-time run trigger on an oscilloscope. The number of samples to be saved after the activity event is specified in FIFO_SAMPLES (Register 0x39[7:0], along with Bit 0 in the FIFO_CTL register, Register 0x3A). For example if the FIFO_SAMPLE is set to 12, there are 500 samples before the trigger and 12 after the trigger. The trigger can be reset by clearing the activity interrupt and reading all 512 locations of the FIFO. If this is not complete, future FIFO data reads may contain invalid data. Place the FIFO into triggered mode by setting the FIFO_MODE bits in the FIFO_CTL register (Register 0x3A) to 0b10.

RETRIEVING DATA FROM FIFO

Access FIFO data by reading the FIFO_DATA register. A multibyte read to this register does not auto-increment the address, and

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FIFO

instead continues to pop data from the FIFO. Data is left justified and formatted as shown in Table 12.

When reading data, the most significant byte (Bits[B15:B8]) is read first, followed by the least significant byte (Bits[B7:B0]).

Bits[B15:B4] represent the 12-bit, twos complement acceleration data. Bit 0 serves as a series start indicator: only the first data byte of a series contains a 1 in this bit, and the remaining items contain a 0.

Table 12. FIFO Buffer Data Format—Bits[B15:B8]

B15 (MSB)	B14	B13	B12	B11	B10	В9	B8	
					Data			
Table 13. FIF	O Buffer Data	Format—Bits[B7	:B0]					
Table 13. FIFO B7	D Buffer Data I B6	Format—Bits[B7 B5	:B0] B4	В3	B2	B1	B0	

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INTERRUPTS

Several of the built in functions of the ADXL372 can trigger interrupts to alert the host processor of certain status conditions. The functionality of these interrupts is described in this section.

INTERRUPT PINS

Interrupts can be mapped to either (or both) of two designated output pins, INT1 and INT2, by setting the appropriate bits in the INT1_MAP register and INT2_MAP register, respectively. All functions can be used simultaneously. If multiple interrupts are mapped to one pin, the OR combination of the interrupts determines the status of the pin.

If no functions are mapped to an interrupt pin, that pin is automatically configured to a high impedance (high-Z) state. The pins are also placed in the high-Z state upon a reset.

When a certain status condition is detected, the pin that condition is mapped to is activated. The configuration of the pin is active high by default so when it is activated, the pin goes high. However, this configuration can be switched to active low by setting the INTx LOW bit in the appropriate INTx MAP register.

The INTx pins can connect to the interrupt input of a host processor where interrupts are responded to with an interrupt routine. Because multiple functions can be mapped to the same pin, the STATUS register can determine which condition caused the interrupt to trigger.

Interrupts are cleared in several of the following ways:

- ▶ Reading the STATUS2 register clears ACTIVITY and INACT interrupts. However, if activity detection is operating in default mode, and the activity or inactivity timers are set to 0, the only way to clear the activity or inactivity bits, respectively, is to set the device into standby mode and restart full bandwidth measurement mode.
- ➤ Setting the device into standby mode and back into full bandwidth measurement mode clears the ACTIVITY2 interrupt.
- Reading from the data registers clears the DATA RDY interrupt.
- ▶ Reading enough data from the FIFO buffer so that interrupt conditions are no longer met, and then reading the STATUS register (Register 0x04) clears the FIFO_RDY, FIFO_FULL, and FIFO_OVR interrupts.

Both interrupt pins are push-pull low impedance pins with an output impedance of about 500 Ω (typical) and digital output specifications as shown in Table 14. Both have bus keepers that hold them to a valid logic state when they are in a high impedance mode.

To prevent interrupts from being falsely triggered during configuration, disable interrupts while their settings, such as thresholds, timings, or other values, are configured.

Alternate Functions

The INT1 and INT2 pins can be configured for use as input pins instead of for signaling interrupts. INT1 is used as an external clock

input when the EXT_CLK bit in the TIMING register is set. INT2 is used as the trigger input for synchronized sampling when the EXT_SYNC bit in the TIMING register is set. One or both of these alternate functions can be used concurrently; however, if an interrupt pin is used for its alternate function, it cannot simultaneously be used to signal interrupts.

TYPES OF INTERRUPTS

Activity and Inactivity Interrupts

The ACTIVITY bit and INACT bit are set when activity and inactivity are detected, respectively. Detection procedures and criteria are described in the Autonomous Event Detection section.

Data Ready Interrupt

The DATA_RDY bit is set when new valid data is available, and it is cleared when no new data is available.

The DATA_RDY bit does not set while any of the data registers are being read. If DATA_RDY = 0 prior to a register read and new data becomes available during the register read, DATA_RDY remains 0 until the read is complete and only then sets to 1.

If DATA_RDY = 1 prior to a register read, it is cleared at the start of the register read.

If DATA_RDY = 1 prior to a register read and new data becomes available during the register read, DATA_RDY is cleared to 0 at the start of the register read and remains 0 throughout the read. When the read is complete, DATA_RDY is set to 1.

FIFO Interrupts

FIFO Watermark

The FIFO_FULL bit is set when the number of samples stored in the FIFO is equal to or exceeds the number specified in FIFO_SAMPLES (Register 0x39 together with Bit 0 in the FIFO_CTL register). The FIFO_FULL bit is cleared automatically when enough samples are read from the FIFO, such that the number of samples remaining is lower than that specified.

If the number of FIFO samples is set to 0, the watermark interrupt is set. To avoid unexpectedly triggering this interrupt, the default value of the FIFO SAMPLES register is 0x80.

FIFO Ready

The FIFO_RDY bit is set when there is at least one valid sample available in the FIFO output buffer. This bit is cleared when no valid data is available in the FIFO. In FIFO triggered mode, it is only set after the activity interrupt is detected, and the data surrounding the event is saved in the FIFO.

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INTERRUPTS

Overrun

The FIFO_OVR bit is set when the FIFO has overrun or overflowed, such that new data replaces unread data, which may indicate a full FIFO that has not yet been emptied or a clocking error caused by a slow SPI transaction. If the FIFO is configured to oldest saved

mode, an overrun event indicates that there is insufficient space available for a new sample.

The FIFO_OVR bit is cleared when both the contents of the FIFO and the STATUS register are read. It is also cleared when the FIFO is disabled.

Table 14. Interrupt Pin Digital Output

			Limit ¹	
Parameter	Test Conditions	Min	Max	Unit
Digital Output				
Low Level Output Voltage (V _{OL})	I _{OL} = 500 μA		$0.2 \times V_{DDI/O}$	V
High Level Output Voltage (V _{OH})	I _{OH} = -300 μA	0.8 × V _{DDI/O}		V
Low Level Output Current (I _{OL})	$V_{OL} = V_{OL, MAX}$	500		μA
High Level Output Current (I _{OH})	V _{OH} = V _{OH, MIN}		-300	μA
Pin Capacitance	$f_{IN} = 1 \text{ MHz}, V_{IN} = 2.0 \text{ V}$		8	pF
Rise/Fall Time				
Rise Time (t _R) ²	C _{LOAD} = 150 pF		210	ns
Fall Time (t _F) ³	C _{LOAD} = 150 pF		150	ns

¹ Limits based on characterization results, not production tested.

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 $^{^2}$ $\,$ Rise time is measured as the transition time from V $_{\rm OL,\,MAX}$ to V $_{\rm OH,\,MIN}$ of the interrupt pin.

 $^{^3}$ Fall time is measured as the transition time from $V_{OH,\,MIN}$ to $V_{OL,\,MAX}$ of the interrupt pin.

ADDITIONAL FEATURES

USING AN EXTERNAL CLOCK

When operating at 3200 Hz ODR or lower, the ADXL372 has a built in 307.2 kHz (typical) clock that, by default, serves as the time base for internal operations. At 6400 Hz ODR, this clock speed increases to 614.4 kHz (typical). If desired, an external clock can be provided instead, for either improved clock frequency accuracy or for control of the output data rate. To use an external clock, set the EXT_CLK bit (Bit 1) in the TIMING register (Register 0x3D) and apply a clock to the INT1 pin.

The external clock can operate at the nominal 307.2 kHz or slower (when using ODR \leq 3200 Hz), or 614.4 kHz or slower (when using ODR = 6400 Hz) to allow the user to achieve any desired output data rate. Lower external clock rates must be used with caution because it may result in aliasing of high frequency signals that may be present in certain applications.

ODR and bandwidth scale proportionally with the clock. The ADXL372 provides a discrete number of options for ODR. ODRs other than those provided are achieved by selecting an appropriate clock frequency. For example, to achieve a 2560 Hz ODR, use the 3200 Hz setting with a clock frequency that is 80% of nominal, or 245.76 kHz. Bandwidth also scales by the same ratio, so if a 400 Hz bandwidth is selected, the resulting bandwidth is 320 Hz.

SYNCHRONIZED DATA SAMPLING

For applications that require a precisely timed acceleration measurement, the ADXL372 features an option to synchronize acceleration sampling to an external trigger. The EXT_SYNC bit in the TIMING register enables this feature. When the EXT_SYNC bit is set to 1, the INT2 pin automatically reconfigures for use as the sync trigger input.

When external triggering is enabled, it is up to the system designer to ensure that the sampling frequency meets system requirements. Sampling too infrequently causes aliasing. Noise can be lowered by oversampling; however, sampling at too high a frequency may not allow enough time for the accelerometer to process the acceleration data and convert it to valid digital output data.

When the Nyquist criterion is met, signal integrity is maintained. An internal antialiasing filter is available in the ADXL372 and can assist the system designer in maintaining signal integrity. To prevent aliasing, set the filter bandwidth to a frequency no greater than half the sampling rate. For example, when sampling at 1600 Hz, set the filter bandwidth to no higher than 800 Hz.

Because of internal timing requirements, the maximum allowable external trigger frequencies are as follows:

- ▶ 1-axis data = 3100 Hz
- ▶ 2-axis data = 2700 Hz
- ▶ 3-axis data = 2200 Hz

These values are doubled when an ODR rate of 6400 Hz is selected. Additionally, the trigger signal applied to the INT2 pin must meet the following criteria:

- ▶ The trigger signal must be active high.
- The pulse width of the trigger signal must be at least 53 μs.
- ➤ The minimum sampling frequency is set only by system requirements. Samples need not be polled at any minimum rate; however, if samples are polled at a rate lower than the bandwidth set by the antialiasing filter, aliasing may occur.

The EXT_SYNC is an active high signal. Due to the asynchronous nature of the internal clock and external sync, there may be a one ODR clock cycle difference between consecutive external sync pulses. The external sync sets the ODR of the system. For example, if sending an external sync at a 2 kHz rate, all 3 axes (if enabled) are sampled in that 2 kHz window.

SELF TEST

The ADXL372 incorporates a pass or fail self test feature that effectively tests its mechanical and electronic systems simultaneously. When the self test function is invoked, an electrostatic force is applied to the mechanical sensor. This electrostatic force moves the mechanical sensing element in the same manner as acceleration, and the acceleration experienced by the device increases because of this force.

Self Test Procedure

The self test function is enabled via the ST bit in the SELF_TEST register, Register 0x40. The recommended procedure for using the self test functionality is as follows:

- 1. Place the device into measurement mode.
- 2. Make sure the low-pass activity filter is enabled.
- Assert self test by setting the ST bit in the SELF_TEST register (Register 0x40).

Read the self test status bits, ST_DONE and USER_ST, after approximately 300 ms to check the pass or fail condition.

USER REGISTER PROTECTION

The ADXL372 includes user register protection for single event upsets (SEUs). An SEU is a change of state caused by ions or electromagnetic radiation striking a sensitive node in a microelectronic device. The state change is a result of the free charge created by ionization in or close to an important node of a logic element (for example, a memory bit). The SEU itself is not considered permanently damaging to transistor or circuit functionality, but can create erroneous register values. The registers protected from SEU are Register 0x20 to Register 0x3F.

Protection is implemented via a 99-bit error correcting (Hamming type) code and detects both single bit and double bit errors. The check bits are recomputed any time a write to any of the protected registers occurs. At any time, if the stored version of the check

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ADDITIONAL FEATURES

bits is not in agreement with the current check bit calculation, the ERR USER REGS status bit is set.

The ERR_USER_REGS bit in the STATUS register starts high when set on an unconfigured device and clears upon the first register write.

USER OFFSET TRIMS

The ADXL372 has a 4-bit offset trim for each axis that allows users to add positive or negative offset to the default static acceleration values and correct any deviations from ideal that may result as a consequence of varying the operating parameters of the device. The offset trims have a full-scale range of about ± 60 LSB with a trim profile as shown in Figure 46.

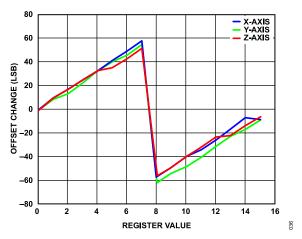


Figure 46. User Offset Trim Profile

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SERIAL COMMUNICATIONS

SERIAL INTERFACE

The ADXL372 is designed to communicate in either the SPI or the I²C protocol. It autodetects the format being used, requiring no configuration control to select the format.

SPI Protocol

The timing scheme is as follows: CPHA = CPOL = 0. The ADXL372 supports a SCLK frequency up to 10 MHz. Wire the ADXL372 for SPI communication as shown in Figure 47. There are no internal pull-up or pull-down resistors for any unused pins. Therefore, there is no known state or default state for the pins if left floating or unconnected. For successful communication, follow the logic thresholds and timing parameters in Table 2. The command structure for the read register and write register are shown in Figure 3 and Figure 4, respectively. The read and write register commands support multibyte (burst) read/write access. The waveform diagrams for multibyte read and write commands are shown in Figure 5 and Figure 6, respectively.

Ignore data transmitted from the ADXL372 to the master device during writes to the ADXL372.

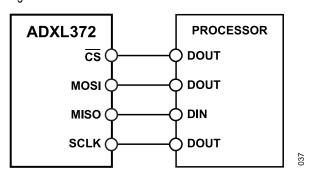


Figure 47. 4-Wire SPI Connection Diagram

I²C Protocol

The ADXL372 supports point to point I²C communication. However, for devices with REVID = 0x02, when sharing an SDA bus, the ADXL372 may prevent communication with other devices on that bus. If at any point, even when the ADXL372 is not being addressed, the 0x3A or 0x3B bytes (when the ADXL372 Device ID is set to 0x1D), or the 0xA6 or 0xA7 bytes (when the ADXL372 Device ID is set to 0x53) are transmitted on the SDA bus, the ADXL372 responds with an acknowledge bit and pulls the SDA line down. For example, this can happen when reading or writing the data bytes to another sensor on the bus. When the ADXL372 pulls the SDA line down, communication with other devices on the bus may be interrupted. To work around this issue, the ADXL372 must be connected to a separate SDA bus, or the SCLK pin must be switched high when communication with the ADXL372 is not desired (it must be normally grounded).

The ADXL372 supports standard (100 kHz), fast (up to 1 MHz), and high speed (up to 3.4 MHz) data transfer modes if the bus

parameters given in Table 3 are met. There is no minimum SCL frequency, with the exception that when reading data, the clock must be fast enough to read an entire sample set before new data overwrites it. Single byte or multibyte reads/writes are supported. With the MISO pin low, the I²C address for the device is 0x1D, and an alternate I²C address of 0x53 can be chosen by pulling the MISO pin high.

There are no internal pull-up or pull-down resistors for any unused pins; therefore, there is no known state or default state for the pins if left floating or unconnected. It is a requirement that SCLK be connected to ground when communicating to the ADXL372 using the $\rm I^2C$.

Due to communication speed limitations, the maximum output data rate when using 400 kHz I^2C is 800 Hz and scales linearly with a change in the I^2C communication speed. For example, using I^2C at 100 kHz limits the maximum ODR to 200 Hz. Operation at an output data rate above the recommended maximum can result in undesirable effect on the acceleration data, including missing samples or additional noise.

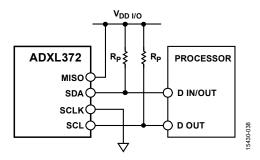


Figure 48. I^2 C Connection Diagram (ADXL372 Device ID = 0x53)

If other devices are connected to the same I^2C bus, the nominal operating voltage level of these other devices cannot exceed $V_{DDI/O}$ by more than 0.3 V. External pull-up resistors, R_P , are necessary for proper I^2C operation. Single byte or multibyte reads/writes are supported, as shown from Figure 8 to Figure 10.

MULTIBYTE TRANSFERS

Both the SPI and I²C protocols support multibyte transfers, also known as burst transfers. A register read or write begins with the address specified in the command and auto-increments for each additional byte in the transfer. Always read acceleration data using multibyte transfers to ensure a concurrent and complete set of x-, y-, and z-acceleration data is read.

The FIFO runs on the serial port clock during FIFO reads and can sustain bursting at the SPI clock rate as long as the SPI clock is 1 MHz or faster.

The address auto-increment function is disabled when the FIFO address is used, which is so that data can be read continuously from the FIFO as a multibyte transaction. In cases where the starting address of a multibyte transaction is less than the FIFO

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SERIAL COMMUNICATIONS

address, the address auto-increments until the FIFO address is reached, and then it stops at the FIFO address.

When writing data to the ADXL372 in I²C mode, the no acknowledge (NACK) is never generated. Instead, the acknowledge (ACK) bit is sent after every received byte because it is not known how many bytes are included in the transfer. The master decides how many bytes are sent and ends the transaction with the stop condition.

INVALID ADDRESSES AND ADDRESS FOLDING

The ADXL372 has a 6-bit address bus, mapping only 104 registers in the possible 256 register address space. The addresses do not fold to repeat the registers at addresses above 0x104. Attempted access to register addresses above 0x104 are mapped to the invalid register at 0x67 and have no functional effect.

Register 0x00 to Register 0x42 are for customer access, as described in Table 15. Register 0x43 to Register 0x67 are reserved for factory use.

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REGISTER MAP

Table 15. Register Map

Reg	Name	Bits	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset	RW
0x00	DEVID_AD	[7:0]				DEVID_	AD				0xAD	R
0x01	DEVID_MST	[7:0]				DEVID_N	MST				0x1D	R
0x02	PARTID	[7:0]				DEVID_PRO	DUCT				0xFA	R
0x03	REVID	[7:0]				REVI)				0x03 ¹	R
0x04	STATUS	[7:0]	ERR_ USER_ REGS	AWAKE	USER_NVM_ BUSY	RESERVED	FIFO_OVR	FIFO_FULL	FIFO_ RDY	DATA_RDY	0xA0	R
0x05	STATUS2	[7:0]	RESERVED	ACTIVITY2	ACTIVITY	INACT		RESE	RVED		0x00	R
0x06	FIFO_ENTRIES2	[7:0]			RESE	RVED			FIFO_ENT	RIES[9:8]	0x00	R
0x07	FIFO_ENTRIES	[7:0]				FIFO_ENTR	ES[7:0]				0x00	R
0x08	XDATA_H	[7:0]				XDATA[1	1:4]				0x00	R
0x09	XDATA_L	[7:0]		Х	(DATA[3:0]			RESE	RVED		0x00	R
0x0A	YDATA_H	[7:0]				YDATA[1	1:4]				0x00	R
0x0B	YDATA_L	[7:0]		Y	'DATA[3:0]			RESE	RVED		0x00	R
0x0C	ZDATA_H	[7:0]				ZDATA[1	1:4]				0x00	R
0x0D	ZDATA_L	[7:0]		Z	'DATA[3:0]			RESE	RVED		0x00	R
0x15	MAXPEAK_X_H	[7:0]				MAXPEAK_	X[11:4]				0x00	R
0x16	MAXPEAK_X_L	[7:0]		MAX	(PEAK_X[3:0]			RESE	RVED		0x00	R
0x17	MAXPEAK_Y_H	[7:0]				MAXPEAK_	Y[11:4]				0x00	R
0x18	MAXPEAK_Y_L	[7:0]		MAX	(PEAK_Y[3:0]			RESE	RVED		0x00	R
0x19	MAXPEAK_Z_H	[7:0]				MAXPEAK_	Z[11:4]				0x00	R
0x1A	MAXPEAK_Z_L	[7:0]		MAX	(PEAK_Z[3:0]			RESE	RVED		0x00	R
0x20	OFFSET_X	[7:0]		R	ESERVED			OFFS	ET_X		0x00	R/W
0x21	OFFSET_Y	[7:0]		R	ESERVED			OFFS	ET_Y		0x00	R/W
0x22	OFFSET_Z	[7:0]		R	ESERVED			OFFS	ET_Z		0x00	R/W
0x23	THRESH_ACT_X_H	[7:0]				THRESH_ACT	Γ_X[10:3]				0x00	R/W
0x24	THRESH_ACT_X_L	[7:0]	Т	HRESH_ACT	_X[2:0]		RESERVED		ACT_REF	ACT_X_EN	0x00	R/W
0x25	THRESH_ACT_Y_H	[7:0]				THRESH_ACT	Γ_Y[10:3]				0x00	R/W
0x26	THRESH_ACT_Y_L	[7:0]	Т	HRESH_ACT	_Y[2:0]		RESEF	RVED		ACT_Y_EN	0x00	R/W
0x27	THRESH_ACT_Z_H	[7:0]				THRESH_AC	Γ_Z[10:3]				0x00	R/W
0x28	THRESH_ACT_Z_L	[7:0]	T	HRESH_ACT	_Z[2:0]		RESEF	RVED		ACT_Z_EN	0x00	R/W
0x29	TIME_ACT	[7:0]				ACT_CO	JNT			'	0x00	R/W
0x2A	THRESH_INACT_X _H	[7:0]				THRESH_INAC	T_X[10:3]				0x00	R/W
0x2B	THRESH_INACT_X _L	[7:0]	Th	HRESH_INAC	T_X[2:0]		RESERVED		INACT_R EF	INACT_X_E N		R/W
0x2C	THRESH_INACT_Y _H	[7:0]				THRESH_INAC					0x00	R/W
0x2D	THRESH_INACT_Y _L	[7:0]	Th	HRESH_INAC	T_Y[2:0]		RESE	RVED		INACT_Y_E N	0x00	R/W
0x2E	THRESH_INACT_Z _H	[7:0]				THRESH_INAC	CT_Z[10:3]				0x00	R/W
0x2F	THRESH_INACT_Z _L	[7:0]	Th	HRESH_INAC	T_Z[2:0]		RESEF	RVED		INACT_Z_E N	0x00	R/W
0x30	TIME_INACT_H	[7:0]				INACT_COU	NT[15:8]				0x00	R/W
0x31	TIME_INACT_L	[7:0]				INACT_COU	NT[7:0]				0x00	R/W
0x32	THRESH_ACT2_X_ H	[7:0]				THRESH_ACT	2_X[10:3]				0x00	R/W

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REGISTER MAP

Table 15. Register Map

Reg	Name	Bits	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset	RW
0x33	THRESH_ACT2_X_ L	[7:0]	T	HRESH_ACT2	2_X[2:0]		RESERVED	1	ACT2_RE F	ACT2_X_E N	0x00	R/W
0x34	THRESH_ACT2_Y_ H	[7:0]				THRESH_ACT	2_Y[10:3]				0x00	R/W
0x35	THRESH_ACT2_Y_ L	[7:0]	T	HRESH_ACT2	2_Y[2:0]		RESEF	RVED		ACT2_Y_E N	0x00	R/W
0x36	THRESH_ACT2_Z_ H	[7:0]				THRESH_ACT	2_Z[10:3]				0x00	R/W
0x37	THRESH_ACT2_Z_ L	[7:0]	Т	HRESH_ACT2	2_Z[2:0]		RESEF	RVED		ACT2_Z_E N	0x00	R/W
0x38	HPF	[7:0]			RESE	RVED			HPF_0	CORNER	0x00	R/W
0x39	FIFO_SAMPLES	[7:0]				FIFO_SAMPI	_ES[7:0]				0x80	R/W
0x3A	FIFO_CTL	[7:0]	RESE	RVED	FIFO_FORMAT		FIFO_N	FIFO_MODE FIFO_SAM PLES[8]		0x00	R/W	
0x3B	INT1_MAP	[7:0]	INT1_ LOW	AWAKE_ INT1	ACT_INT1	INACT_INT1	FIFO_ OVR_ INT1	FIFO_ FULL_ INT1	FIFO_ RDY_ INT1	DATA_ RDY_ INT1	0x00	R/W
0x3C	INT2_MAP	[7:0]	INT2_LOW	AWAKE_ INT2	ACT2_INT2	INACT_INT2	FIFO_ OVR_ INT2	FIFO_ FULL_ INT2	FIFO_ RDY_ INT2	DATA_ RDY_ INT2	0x00	R/W
0x3D	TIMING	[7:0]		ODR		1	WAKEUP_RATE		EXT_CLK	EXT_SYNC	0x00	R/W
0x3E	MEASURE	[7:0]	USER_ OR_ DISABLE	AUTOSLE EP	LINKL	OOP	LOW_ NOISE	BANDWIDTH		İ	0x00	R/W
0x3F	POWER_CTL	[7:0]	I2C_ HSM_ EN	RESERVE D	INSTANT_ ON_ THRESH	FILTER_ SETTLE	LPF_ DISABLE	HPF_ DISABLE	M	ODE	0x00	R/W
0x40	SELF_TEST	[7:0]			RESERVED	'		USER_ST	ST_DONE	ST	0x00	R/W
0x41	RESET	[7:0]				RESE	Т				0x00	W
0x42	FIFO_DATA	[7:0]				FIFO_D/	ATA				0x00	R

 $^{^{\,1}\,}$ The reset value of the REVID register is either 0x03 or 0x02 for the ADXL372.

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REGISTER DETAILS

ANALOG DEVICES ID REGISTER

Address: 0x00, Reset: 0xAD, Name: DEVID_AD

This register contains the Analog Devices, Inc., ID, 0xAD.

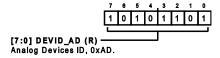


Figure 49.

Table 16. Bit Descriptions for DEVID AD

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	DEVID_AD		Analog Devices ID, 0xAD.	0xAD	R

ANALOG DEVICES MEMS ID REGISTER

Address: 0x01, Reset: 0x1D, Name: DEVID_MST

This register contains the Analog Devices MEMS ID, 0x1D.

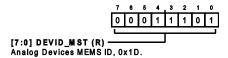


Figure 50.

Table 17. Bit Descriptions for DEVID MST

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	DEVID_MST		Analog Devices MEMS ID, 0x1D.	0x1D	R

DEVICE ID REGISTER

Address: 0x02, Reset: 0xFA, Name: PARTID

This register contains the device ID, 0xFA (372 octal).

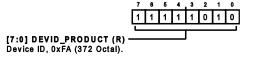


Figure 51.

Table 18. Bit Descriptions for PARTID

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	DEVID_PRODUCT		Device ID, 0xFA (372 Octal).	0xFA	R

PRODUCT REVISION ID REGISTER

Address: 0x03, Reset: 0x02, Name: REVID

This register contains the mask revision ID, beginning with 0x00 and incrementing for each subsequent revision.

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REGISTER DETAILS

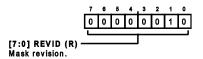


Figure 52.

Table 19. Bit Descriptions for REVID

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	REVID		Mask revision.	0x2	R

STATUS REGISTER

Address: 0x04, Reset: 0xA0, Name: STATUS

This register includes the following bits that describe various conditions of the ADXL372.

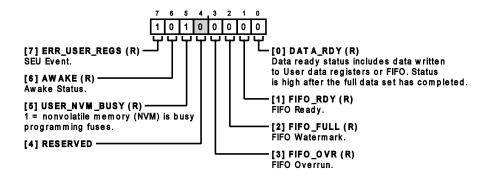


Figure 53.

Table 20. Bit Descriptions for STATUS

Bits	Bit Name	Settings	Description	Reset	Access
7	ERR_USER_REGS		SEU Event. An SEU event has been detected in a user register.	0x1	R
6	AWAKE		Awake Status. Activity has been detected and the device is moving.	0x0	R
5	USER_NVM_BUSY		1 = nonvolatile memory (NVM) is busy programming fuses.	0x1	R
4	RESERVED		Reserved.	0x0	R
3	FIFO_OVR		FIFO Overrun. FIFO has overflowed, and data has been lost.	0x0	R
2	FIFO_FULL		FIFO Watermark. The FIFO watermark level, specified in FIFO_SAMPLES, has been reached.	0x0	R
1	FIFO_RDY		FIFO Ready. At least one valid sample is available in the FIFO.	0x0	R
0	DATA_RDY		Data ready status includes data written to user data registers or FIFO. Status is high after the full data set has completed. A complete x, y, and z measurement has been made and results can be read.	0x0	R

ACTIVITY STATUS REGISTER

Address: 0x05, Reset: 0x00, Name: STATUS2

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REGISTER DETAILS

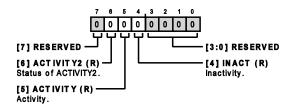


Figure 54.

Table 21. Bit Descriptions for STATUS2

Bits	Bit Name	Settings	Description	Reset	Access
7	RESERVED		Reserved.	0x0	R
6	ACTIVITY2		Status of ACTIVITY2.	0x0	R
5	ACTIVITY		Activity. Activity has been detected.	0x0	R
4	INACT		Inactivity. Inactivity has been detected.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

FIFO ENTRIES REGISTER, MSB

Address: 0x06, Reset: 0x00, Name: FIFO_ENTRIES2

The FIFO_ENTRIES2 and FIFO_ENTRIES registers indicate the number of valid data samples present in the FIFO buffer. The number ranges from 0 to 512 or 0x00 to 0x200. FIFO_ENTRIES contains the least significant byte, and FIFO_ENTRIES2 contains the two most significant bits.

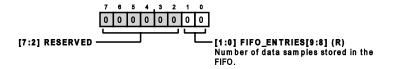


Figure 55.

Table 22. Bit Descriptions for FIFO_ENTRIES2

Bits	Bit Name	Settings	Description	Reset	Access
[7:2]	RESERVED		Reserved.	0x0	R
[1:0]	FIFO_ENTRIES[9:8]		Number of data samples stored in the FIFO.	0x0	R

FIFO ENTRIES REGISTER, LSB

Address: 0x07, Reset: 0x00, Name: FIFO_ENTRIES

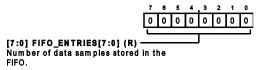


Figure 56.

Table 23. Bit Descriptions for FIFO ENTRIES

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	FIFO_ENTRIES[7:0]		Number of data samples stored in the FIFO.	0x0	R

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REGISTER DETAILS

X-AXIS DATA REGISTER, MSB

Address: 0x08, Reset: 0x00, Name: XDATA_H

These two registers contain the x-axis acceleration data. Data is left justified and formatted as twos complement. XDATA_H contains the eight most significant bits (MSBs), and XDATA_L contains the four least significant bits (LSBs) of the 12-bit value.

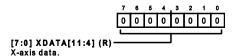


Figure 57.

Table 24. Bit Descriptions for XDATA_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	XDATA[11:4]		X-axis data.	0x0	R

X-AXIS DATA REGISTER, LSB

Address: 0x09, Reset: 0x00, Name: XDATA_L

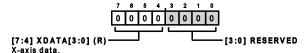


Figure 58.

Table 25. Bit descriptions for XDATA_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	XDATA[3:0]		X-axis data.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

Y-AXIS DATA REGISTER, MSB

Address: 0x0A, Reset: 0x00, Name: YDATA_H

The YDATA_H and YDATA_L registers contain the y-axis, LSB acceleration data. Data is left justified and formatted as twos complement. YDATA H contains the eight most significant bits (MSBs), and YDATA L contains the four least significant bits (LSBs) of the 12-bit value.

YDATA_L latches on a read of YDATA_H to ensure data integrity.

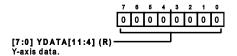


Figure 59.

Table 26. Bit Descriptions for YDATA_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	YDATA[11:4]		Y-axis data.	0x0	R

Y-AXIS DATA REGISTER, LSB

Address: 0x0B, Reset: 0x00, Name: YDATA L

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REGISTER DETAILS

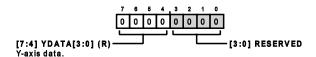


Figure 60.

Table 27. Bit Descriptions for YDATA L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	YDATA[3:0]		Y-axis data.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

Z-AXIS DATA REGISTER, MSB

Address: 0x0C, Reset: 0x00, Name: ZDATA_H

These two registers contain the z-axis acceleration data. Data is left justified and formatted as twos complement. ZDATA_H contains the eight most significant bits (MSBs), and ZDATA_L contains the four least significant bits (LSBs) of the 12-bit value.

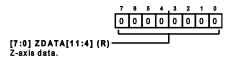


Figure 61.

Table 28. Bit Descriptions for ZDATA H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	ZDATA[11:4]		Z-axis data.	0x0	R

Z-AXIS DATA REGISTER, LSB

Address: 0x0D, Reset: 0x00, Name: ZDATA_L

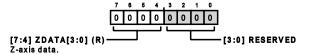


Figure 62.

Table 29. Bit Descriptions for ZDATA L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	ZDATA[3:0]		Z-axis data.	0x0	R
[3:0]	RESERVED		Reserved.	0x0	R

HIGHEST PEAK DATA REGISTERS

The highest peak data registers contain the acceleration data corresponding to the highest magnitude sample recorded since the last read of this register. Data is left justified and formatted as twos complement.

X-AXIS HIGHEST PEAK DATA REGISTER, MSB

Address: 0x15, Reset: 0x00, Name: MAXPEAK_X_H

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REGISTER DETAILS

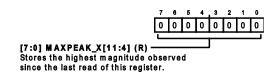


Figure 63.

Table 30. Bit Descriptions for MAXPEAK X H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	MAXPEAK_X[11:4]		Stores the highest magnitude observed since the last read of this register.	0x0	R
			The 8 MSBs of the x-axis value.		

X-AXIS HIGHEST PEAK DATA REGISTER, LSB

Address: 0x16, Reset: 0x00, Name: MAXPEAK_X_L

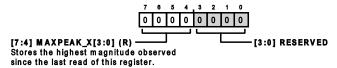


Figure 64.

Table 31. Bit Descriptions for MAXPEAK X L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	MAXPEAK_X[3:0]		Stores the highest magnitude observed since the last read of this register.	0x0	R
			The 4 LSBs of the x-axis value.		
[3:0]	RESERVED		Reserved.	0x0	R

Y-AXIS HIGHEST PEAK DATA REGISTER, MSB

Address: 0x17, Reset: 0x00, Name: MAXPEAK_Y_H

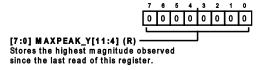


Figure 65.

Table 32. Bit Descriptions for MAXPEAK_Y_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	MAXPEAK_Y[11:4]		Stores the highest magnitude observed since the last read of this register.	0x0	R
			The 8 MSBs of the y-axis value.		

Y-AXIS HIGHEST PEAK DATA REGISTER, LSB

Address: 0x18, Reset: 0x00, Name: MAXPEAK_Y_L

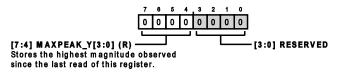


Figure 66.

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REGISTER DETAILS

Table 33. Bit Descriptions for MAXPEAK Y L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	MAXPEAK_Y[3:0]		Stores the highest magnitude observed since the last read of this register.	0x0	R
			The 4 LSBs of the y-axis value.		
[3:0]	RESERVED		Reserved.	0x0	R

Z-AXIS HIGHEST PEAK DATA REGISTER, MSB

Address: 0x19, Reset: 0x00, Name: MAXPEAK_Z_H

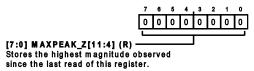


Figure 67.

Table 34. Bit Descriptions for MAXPEAK Z H

Bits	Bit Name	Settings	Description		Access
[7:0]	MAXPEAK_Z[11:4]		Stores the highest magnitude observed since the last read of this register.	0x0	R
			The 8 MSBs of the z-axis value.		

Z-AXIS HIGHEST PEAK DATA REGISTER, LSB

Address: 0x1A, Reset: 0x00, Name: MAXPEAK_Z_L

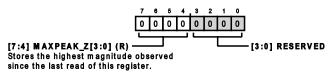


Figure 68.

Table 35. Bit Descriptions for MAXPEAK Z L

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	MAXPEAK_Z[3:0]		Stores the highest magnitude observed since the last read of this register.	0x0	R
			The 4 LSBs of the z-axis value.		
[3:0]	RESERVED		Reserved.	0x0	R

OFFSET TRIM REGISTERS

Offset trim registers are each four bits and offer user set, offset adjustments in twos complement format. The scale factor of these registers is shown in Figure 46.

X-AXIS OFFSET TRIM REGISTER, LSB

Address: 0x20, Reset: 0x00, Name: OFFSET_X

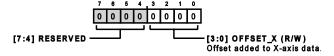


Figure 69.

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REGISTER DETAILS

Table 36. Bit Descriptions for OFFSET X

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	RESERVED		Reserved.	0x0	R
[3:0]	OFFSET_X		Offset added to x-axis data.	0x0	R/W

Y-AXIS OFFSET TRIM REGISTER, LSB

Address: 0x21, Reset: 0x00, Name: OFFSET_Y

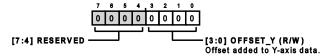


Figure 70.

Table 37. Bit Descriptions for OFFSET Y

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	RESERVED		Reserved.	0x0	R
[3:0]	OFFSET_Y		Offset added to y-axis data.	0x0	R/W

Z-AXIS OFFSET TRIM REGISTER, LSB

Address: 0x22, Reset: 0x00, Name: OFFSET_Z

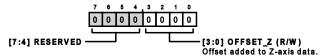


Figure 71.

Table 38. Bit Descriptions for OFFSET_Z

Bits	Bit Name	Settings	Description	Reset	Access
[7:4]	RESERVED		Reserved.	0x0	R
[3:0]	OFFSET_Z		Offset added to z-axis data.	0x0	R/W

X-AXIS ACTIVITY THRESHOLD REGISTER, MSB

Address: 0x23, Reset: 0x00, Name: THRESH_ACT_X_H

This 11-bit unsigned value sets the threshold for activity detection. This value is set in codes and the scale factor is 100 mg/code. To detect activity, the absolute value of the 12-bit acceleration data is compared with the 11-bit (unsigned) activity threshold value. The THRESH_ACT_x_L register contains the least significant bits and the THRESH_ACT_x_H register contains the most significant byte of the activity threshold value.



Figure 72.

Table 39. Bit Descriptions for THRESH_ACT_X_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_ACT_X[10:3]		Threshold for activity detection. The 8 MSBs of x-axis threshold.	0x0	R/W

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REGISTER DETAILS

X-AXIS OF ACTIVITY THRESHOLD REGISTER, LSB

Address: 0x24, Reset: 0x00, Name: THRESH_ACT_X_L

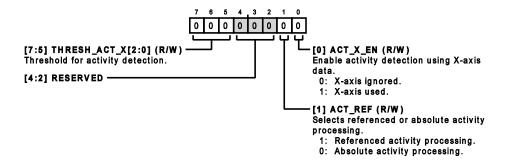


Figure 73.

Table 40. Bit Descriptions for THRESH ACT X L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_ACT_X[2:0]		Threshold for activity detection. The 3 LSBs of x-axis threshold.	0x0	R/W
[4:2]	RESERVED		Reserved.	0x0	R
1	ACT_REF		Selects referenced or absolute activity processing.	0x0	R/W
			Referenced activity processing.		
			Absolute activity processing.		
)	ACT_X_EN		Enable activity detection using X-axis data.	0x0	R/W
		(X-axis ignored.		
			X-axis used.		

Y-AXIS ACTIVITY THRESHOLD REGISTER, MSB

Address: 0x25, Reset: 0x00, Name: THRESH_ACT_Y_H



Figure 74.

Table 41. Bit Descriptions for THRESH_ACT_Y_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_ACT_Y[10:3]		Threshold for activity detection. The 8 MSBs of y-axis threshold.	0x0	R/W

Y-AXIS OF ACTIVITY THRESHOLD REGISTER, LSB

Address: 0x26, Reset: 0x00, Name: THRESH_ACT_Y_L

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REGISTER DETAILS

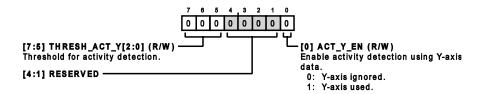


Figure 75.

Table 42. Bit Descriptions for THRESH ACT Y L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_ACT_Y[2:0]		Threshold for activity detection. The 3 LSBs of y-axis threshold.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	ACT_Y_EN		Enable activity detection using y-axis data.	0x0	R/W
		0	Y-axis ignored.		
		1	Y-axis used.		

Z-AXIS ACTIVITY THRESHOLD REGISTER, MSB

Address: 0x27, Reset: 0x00, Name: THRESH_ACT_Z_H

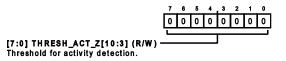


Figure 76.

Table 43. Bit Descriptions for THRESH ACT Z H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_ACT_Z[10:3]		Threshold for activity detection. The 8 MSBs of z-axis threshold.	0x0	R/W

Z-AXIS OF ACTIVITY THRESHOLD REGISTER, LSB

Address: 0x28, Reset: 0x00, Name: THRESH_ACT_Z_L

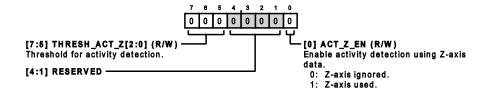


Figure 77.

Table 44. Bit Descriptions for THRESH ACT Z L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_ACT_Z[2:0]		Threshold for activity detection. The 3 LSBs of z-axis threshold.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	ACT_Z_EN		Enable activity detection using Z-axis data.	0x0	R/W
		0	Z-axis ignored.		
		1	Z-axis used.		

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REGISTER DETAILS

ACTIVITY TIME REGISTER

Address: 0x29, Reset: 0x00, Name: TIME_ACT

The activity timer implements a robust activity detection that minimizes false positive motion triggers. When the timer is used, only sustained motion can trigger activity detection. The time (in milliseconds) is given by the following equation:

 $Time = TIME_ACT \times 3.3 \text{ ms per code}$

where:

TIME ACT is the value set in this register.

3.3 ms per code is the scale factor of the TIME_ACT register for ODR = 6400 Hz. It is 6.6 ms per code for ODR = 3200 Hz and below. See the Activity Timer section for more information.

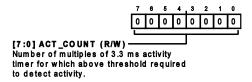


Figure 78.

Table 45. Bit Descriptions for TIME ACT

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	ACT_COUNT		Number of multiples of 3.3 ms activity timer for which above threshold acceleration is required to detect activity. It is 3.3 ms per code for 6400 Hz ODR, and it is 6.6 ms per code for 3200 Hz ODR and below.	0x0	R/W

X-AXIS INACTIVITY THRESHOLD REGISTER, MSB

Address: 0x2A, Reset: 0x00, Name: THRESH_INACT_X_H

This 11-bit unsigned value sets the threshold for inactivity detection. This value is set in codes and the scale factor is 100 mg/code. To detect inactivity, the absolute value of the 12-bit acceleration data is compared with the 11-bit (unsigned) inactivity threshold value. The THRESH_INACT_x_L register contains the least significant bits and the THRESH_INACT_x_H register contains the most significant byte of the inactivity threshold value.



Figure 79.

Table 46. Bit Descriptions for THRESH_INACT_X_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_INACT_X[10:3]		Threshold for inactivity detection. The 8 MSBs of x-axis.	0x0	R/W

X-AXIS OF INACTIVITY THRESHOLD REGISTER, LSB

Address: 0x2B, Reset: 0x00, Name: THRESH_INACT_X_L

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REGISTER DETAILS

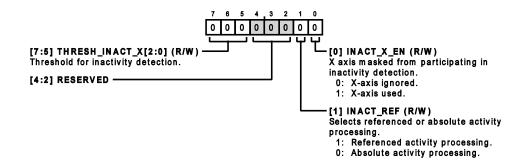


Figure 80.

Table 47. Bit Descriptions for THRESH INACT X L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_INACT_X[2:0]		Threshold for inactivity detection. The 3 LSBs of the x-axis.	0x0	R/W
[4:2]	RESERVED		Reserved.	0x0	R
1	INACT_REF		Selects referenced or absolute inactivity processing.	0x0	R/W
		1	Referenced inactivity processing.		
		(Absolute inactivity processing.		
)	INACT_X_EN		X-axis masked from participating in inactivity detection.	0x0	R/W
		(X-axis ignored.		
		1	X-axis used.		

Y-AXIS INACTIVITY THRESHOLD REGISTER, MSB

Address: 0x2C, Reset: 0x00, Name: THRESH_INACT_Y_H



Figure 81.

Table 48. Bit Descriptions for THRESH INACT Y H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_INACT_Y[10:3]		Threshold for inactivity detection. The 8 MSBs of the y-axis.	0x0	R/W

Y-AXIS OF INACTIVITY THRESHOLD REGISTER, LSB

Address: 0x2D, Reset: 0x00, Name: THRESH_INACT_Y_L

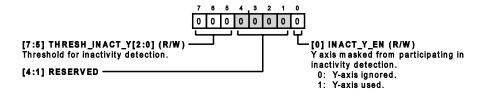


Figure 82.

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REGISTER DETAILS

Table 49. Bit Descriptions for THRESH INACT Y L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_INACT_Y[2:0]		Threshold for inactivity detection. The 3 LSBs of the y-axis.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	INACT_Y_EN		Y-axis masked from participating in inactivity detection.	0x0	R/W
		0	Y-axis ignored.		
		1	Y-axis used.		

Z-AXIS INACTIVITY THRESHOLD REGISTER, MSB

Address: 0x2E, Reset: 0x00, Name: THRESH_INACT_Z_H

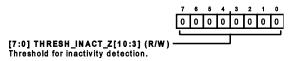


Figure 83.

Table 50. Bit Descriptions for THRESH INACT Z H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	THRESH_INACT_Z[10:3]		Threshold for inactivity detection. The 8 MSBs of the z-axis.	0x0	R/W

Z-AXIS OF INACTIVITY THRESHOLD REGISTER, LSB

Address: 0x2F, Reset: 0x00, Name: THRESH_INACT_Z_L

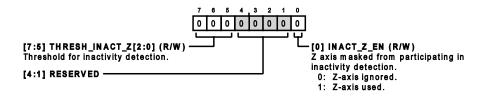


Figure 84.

Table 51. Bit Descriptions for THRESH_INACT_Z_L

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	THRESH_INACT_Z[2:0]		Threshold for inactivity detection. The 3 LSBs of the z-axis.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	INACT_Z_EN		Z-axis masked from participating in inactivity detection.	0x0	R/W
		0	Z-axis ignored.		
		1	Z-axis used.		

INACTIVITY TIME REGISTERS

The 16-bit value in these registers sets the time that all enabled axes must be lower than the inactivity threshold for an inactivity event to be detected. The TIME_INACT_L register holds the eight LSBs, and the TIME_INACT_H register holds the eight MSBs of the 16-bit TIME_INACT value.

Calculate the time as follows:

 $Time = TIME_INACT \times 26 \text{ ms per code}$

where:

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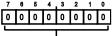
REGISTER DETAILS

TIME_INACT is the 16-bit value set by the TIME_INACT_L register (eight LSBs) and the TIME_INACT_H register (eight MSBs).

26 ms per code is the scale factor of the TIME_INACT_L and TIME_INACT_H registers for 3200 Hz and below. It is 13 ms per code of ODR = 6400 Hz. See the Inactivity Timer section for more information.

INACTIVITY TIMER REGISTER, MSB

Address: 0x30, Reset: 0x00, Name: TIME_INACT_H



[7:0] INACT_COUNT[15:8] (R/W) —
Number of multiples of 26 ms inactivity
timer for which below threshold required
to detect inactivity.

Figure 85.

Table 52. Bit Descriptions for TIME_INACT_H

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	INACT_COUNT[15:8]		Number of multiples of 26 ms inactivity timer for which below threshold acceleration is required to detect inactivity. It is 26 ms per code for 3200 Hz ODR and below, and it is 13 ms per code for 6400 Hz ODR.	0x0	R/W

INACTIVITY TIMER REGISTER, LSB

Address: 0x31, Reset: 0x00, Name: TIME_INACT_L



Number of multiples of 26 ms inactivity timer for which below threshold required to detect inactivity.

Figure 86.

Table 53. Bit Descriptions for TIME INACT L

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	INACT_COUNT[7:0]		Number of multiples of 26 ms inactivity timer for which below threshold acceleration is required to detect inactivity.	0x0	R/W

X-AXIS MOTION WARNING THRESHOLD REGISTER, MSB

Address: 0x32, Reset: 0x00, Name: THRESH_ACT2_X_H

This 11-bit unsigned value sets the threshold for motion detection. This value is set in codes and the scale factor is 100 mg/code. To detect motion, the absolute value of the 12-bit acceleration data is compared with the 11-bit (unsigned) ACTIVITY2 threshold value. The THRESH_ACT2_x_L register contains the least significant bits and the THRESH_ACT2_x_H register contains the most significant byte of the ACTIVITY2 threshold value.



Figure 87.

Table 54. Bit Descriptions for THRESH ACT2 X H

Bits	Bit Name	Settings	Description ¹	Reset	Access
[7:0]	THRESH_ACT2_X[10:3]		OTN Threshold. The 8 MSBs of the x-axis threshold for motion warning interrupt.	0x0	R/W

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REGISTER DETAILS

X-AXIS OF MOTION WARNING NOTIFICATION REGISTER, LSB

Address: 0x33, Reset: 0x00, Name: THRESH_ACT2_X_L

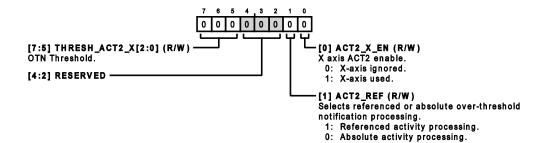


Figure 88.

Table 55. Bit Descriptions for THRESH ACT2 X L

Bits	Bit Name	Settings	Description ¹	Reset	Access
[7:5]	THRESH_ACT2_X[2:0]		OTN Threshold. The 3 LSBs of the x-axis threshold for motion warning interrupt.	0x0	R/W
[4:2]	RESERVED		Reserved.	0x0	R
1	ACT2_REF		Selects referenced or absolute motion warning notification processing.	0x0	R/W
		1	Referenced activity processing.		
		0	Absolute activity processing.		
0	ACT2_X_EN		X-axis ACT2 enable. When set to 1, the x-axis participates in motion warning notification detection.	0x0	R/W
		0	X-axis ignored.		
		1	X-axis used.		

¹ OTN stands for other threshold notification, and ACT2 stands for ACTIVITY2.

Y-AXIS MOTION WARNING NOTIFICATION THRESHOLD REGISTER, MSB

Address: 0x34, Reset: 0x00, Name: THRESH_ACT2_Y_H

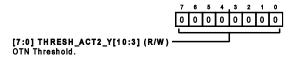


Figure 89.

Table 56. Bit Descriptions for THRESH ACT2 Y H

Bits	Bit Name	Settings	Description ¹	Reset	Access
[7:0]	THRESH_ACT2_Y[10:3]		OTN Threshold. The 8 MSBs of the y-axis threshold for motion warning interrupt.	0x0	R/W

¹ OTN stands for other threshold notification.

Y-AXIS OF MOTION WARNING NOTIFICATION REGISTER, LSB

Address: 0x35, Reset: 0x00, Name: THRESH_ACT2_Y_L

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¹ OTN stands for other threshold notification.

REGISTER DETAILS

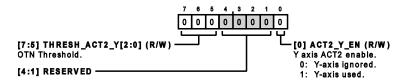


Figure 90.

Table 57. Bit Descriptions for THRESH ACT2 Y L

Bits	Bit Name	Settings	Description ¹	Reset	Access
[7:5]	THRESH_ACT2_Y[2:0]		OTN Threshold. The 3 LSBs of the y-axis threshold for motion warning interrupt.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	ACT2_Y_EN		Y-axis ACT2 enable. When 1, the y-axis participates in motion warning notification detection.	0x0	R/W
		0	Y-axis ignored.		
		1	Y-axis used.		

¹ OTN stands for other threshold notification, and ACT2 stands for ACTIVITY2.

Z-AXIS MOTION WARNING NOTIFICATION THRESHOLD REGISTER, MSB

Address: 0x36, Reset: 0x00, Name: THRESH_ACT2_Z_H



Figure 91.

Table 58. Bit Descriptions for THRESH_ACT2_Z_H

Bits	Bit Name	Settings	Description ¹	Reset	Access
[7:0]	THRESH_ACT2_Z[10:3]		OTN Threshold. The 8 MSBs of the z-axis threshold for motion warning interrupt.	0x0	R/W

¹ OTN stands for other threshold notification.

Z-AXIS MOTION WARNING NOTIFICATION REGISTER, LSB

Address: 0x37, Reset: 0x00, Name: THRESH_ACT2_Z_L

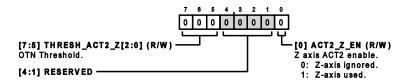


Figure 92.

Table 59. Bit Descriptions for THRESH ACT2 Z L

Bits	Bit Name	Settings	Description ¹	Reset	Access
[7:5]	THRESH_ACT2_Z[2:0]		OTN Threshold. The 3 LSBs of the z-axis threshold for motion warning interrupt.	0x0	R/W
[4:1]	RESERVED		Reserved.	0x0	R
0	ACT2_Z_EN		Z-axis ACT2 enable. When 1, the z-axis participates in motion warning notification detection.	0x0	R/W
		0	Z-axis ignored.		

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REGISTER DETAILS

Table 59. Bit Descriptions for THRESH ACT2 Z L

Bits	Bit Name	Settings	Description ¹	Reset	Access
		1	Z-axis used.		

OTN stands for other threshold notification, and ACT2 stands for ACTIVITY2.

HIGH-PASS FILTER SETTINGS REGISTER

Address: 0x38, Reset: 0x00, Name: HPF

Use this register to specify parameters for the internal high-pass filter.

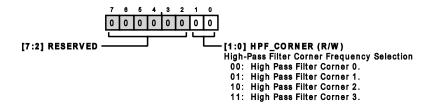


Figure 93.

Table 60. Bit Descriptions for HPF

Bits	Bit Name	Settings	Description	Reset	Access
[7:2]	RESERVED		Reserved.	0x0	R
[1:0]	HPF_CORNER		High-Pass Filter Corner Frequency Selection.	0x0	R/W
		00	High Pass Filter Corner 0. At ODR 6400 Hz = 30.48 Hz, at ODR 3200 Hz = 15.24 Hz, at ODR 1600 Hz = 7.61 Hz, at ODR 800 Hz = 3.81 Hz, and at ODR 400 Hz = 1.90 Hz.		
		01	High Pass Filter Corner 1. At ODR 6400 Hz = 15.58 Hz, at ODR 3200 Hz = 7.79 Hz, at ODR 1600 Hz = 3.89 Hz, at ODR 800 Hz = 1.94 Hz, and at ODR 400 Hz = 0.97 Hz.		
		10	High Pass Filter Corner 2. At ODR 6400 Hz = 7.88 Hz, at ODR 3200 Hz = 3.94 Hz, at ODR 1600 Hz = 1.97 Hz, at ODR 800 Hz = 0.98 Hz, and at ODR 400 Hz = 0.49 Hz.		
		11	High Pass Filter Corner 3. At ODR 6400 Hz = 3.96 Hz, at ODR 3200 Hz = 1.98 Hz, at ODR 1600 Hz = 0.99 Hz, at ODR 800 Hz = 0.49 Hz, and at ODR 400 Hz = 0.24 Hz.		

FIFO SAMPLES REGISTER

Address: 0x39, Reset: 0x80, Name: FIFO_SAMPLES

Use the FIFO_SAMPLES value to specify the number of samples to store in the FIFO. The 8 least significant bits (LSBs) of the FIFO_SAMPLES value are stored in this register. The most significant bit (MSB) of the FIFO_SAMPLES value is Bit 0 of the FIFO_CTL register.

The default value of this register is 0x80 to avoid triggering the FIFO watermark interrupt (see the FIFO Watermark section for more information). In trigger FIFO mode, FIFO SAMPLES program the number of samples to be saved after the trigger is detected.

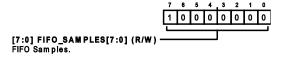


Figure 94.

Table 61. Bit Descriptions for FIFO_SAMPLES

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	FIFO_SAMPLES[7:0]		FIFO Samples. Watermark number of FIFO samples that triggers a FIFO_FULL condition when reached. Values range from 0 to 512.	0x80	R/W

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REGISTER DETAILS

FIFO CONTROL REGISTER

Address: 0x3A, Reset: 0x00, Name: FIFO_CTL

Use this register to specify the operating parameters for the FIFO.

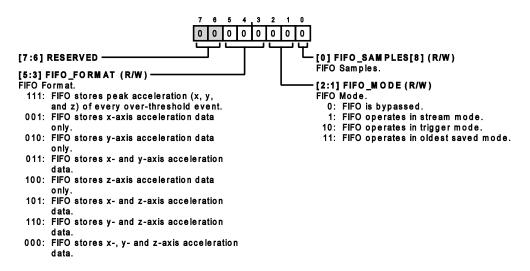


Figure 95.

Table 62. Bit Descriptions for FIFO CTL

Bits	Bit Name	Settings	Description	Reset	Access
[7:6]	RESERVED		Reserved.	0x0	R
[5:3]	FIFO_FORMAT		FIFO Format. Specifies which data is stored in the FIFO buffer.	0x0	R/W
		111	FIFO stores peak acceleration (x, y, and z) of every over threshold event.		
		001	FIFO stores x-axis acceleration data only.		
		010	FIFO stores y-axis acceleration data only.		
		011	FIFO stores x- and y-axis acceleration data.		
		100	FIFO stores z-axis acceleration data only.		
	101	FIFO stores x- and z-axis acceleration data.			
		110	FIFO stores y- and z-axis acceleration data.		
		000	FIFO stores x-, y- and z-axis acceleration data.		
2:1]	FIFO_MODE		FIFO Mode. Specifies FIFO operating mode.	0x0	R/W
		0	FIFO is bypassed.		
		1	FIFO operates in stream mode.		
		10	FIFO operates in trigger mode.		
		11	FIFO operates in oldest saved mode.		
)	FIFO_SAMPLES[8]		FIFO Samples. Watermark number of FIFO samples that triggers a FIFO_FULL condition when reached. Values range from 0 to 512.	0x0	R/W

INTERRUPT PIN FUNCTION MAP REGISTERS

Address: 0x3B, Reset: 0x00, Name: INT1_MAP

The INT1_MAP and INT2_MAP registers configure the INT1 and INT2 interrupt pins, respectively. Bits[6:0] select which function(s) generate an interrupt on the pin. If its corresponding bit is set to 1, the function generates an interrupt on the INTx pin. Bit B7 configures whether the pin operates in active high (B7 low) or active low (B7 high) mode. Any number of functions can be selected simultaneously for each pin. If multiple functions are selected, their conditions are OR'ed together to determine the INTx pin state. The status of each function can be determined by reading the status register. If no interrupts are mapped to an INTx pin, the pin remains in a high impedance state.

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REGISTER DETAILS

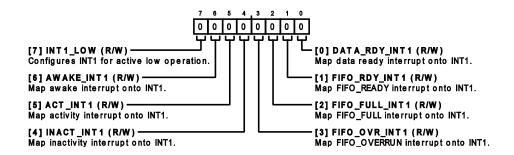


Figure 96.

Table 63. Bit Descriptions for INT1 MAP

Bits	Bit Name	Settings	Description	Reset	Access
7	INT1_LOW		Configures INT1 for active low operation.	0x0	R/W
6	AWAKE_INT1		Map awake interrupt onto INT1.	0x0	R/W
5	ACT_INT1		Map activity interrupt onto INT1.	0x0	R/W
4	INACT_INT1		Map inactivity interrupt onto INT1.	0x0	R/W
3	FIFO_OVR_INT1		Map FIFO_OVERRUN interrupt onto INT1.	0x0	R/W
2	FIFO_FULL_INT1		Map FIFO_FULL interrupt onto INT1.	0x0	R/W
1	FIFO_RDY_INT1		Map FIFO_READY interrupt onto INT1.	0x0	R/W
0	DATA_RDY_INT1		Map data ready interrupt onto INT1.	0x0	R/W

INT2 FUNCTION MAP REGISTER

Address: 0x3C, Reset: 0x00, Name: INT2_MAP

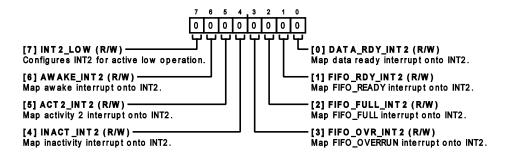


Figure 97.

Table 64. Bit Descriptions for INT2_MAP

Bits	Bit Name	Settings	Description	Reset	Access
7	INT2_LOW		Configures INT2 for active low operation.	0x0	R/W
6	AWAKE_INT2		Map awake interrupt onto INT2.	0x0	R/W
5	ACT2_INT2		Map Activity 2 (motion warning) interrupt onto INT2.	0x0	R/W
4	INACT_INT2		Map inactivity interrupt onto INT2.	0x0	R/W
3	FIFO_OVR_INT2		Map FIFO_OVERRUN interrupt onto INT2.	0x0	R/W
2	FIFO_FULL_INT2		Map FIFO_FULL interrupt onto INT2.	0x0	R/W
1	FIFO_RDY_INT2		Map FIFO_READY interrupt onto INT2.	0x0	R/W
0	DATA_RDY_INT2		Map data ready interrupt onto INT2.	0x0	R/W

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REGISTER DETAILS

EXTERNAL TIMING CONTROL REGISTER

Address: 0x3D, Reset: 0x00, Name: TIMING

Use this register to control the ADXL372 timing parameters: ODR and external timing triggers.

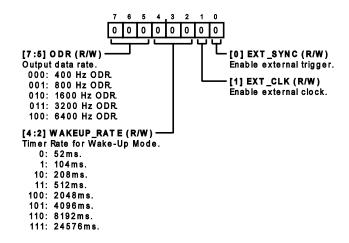


Figure 98.

Table 65. Bit Descriptions for TIMING

Bits	Bit Name	Settings	Description	Reset	Access
[7:5]	ODR		Output data rate.	0x0	R/W
		000	400 Hz ODR.		
		001	800 Hz ODR.		
		010	1600 Hz ODR.		
		011	3200 Hz ODR.		
		100	6400 Hz ODR.		
[4:2]	WAKEUP_RATE		Timer Rate for Wake-Up Mode.	0x0	R/W
		0	52 ms.		
		1	104 ms.		
		10	208 ms.		
		11	512 ms.		
		100	2048 ms.		
		101	4096 ms.		
		110	8192 ms.		
		111	24576 ms.		
1	EXT_CLK		Enable external clock.	0x0	R/W
0	EXT_SYNC		Enable external trigger.	0x0	R/W

MEASUREMENT CONTROL REGISTER

Address: 0x3E, Reset: 0x00, Name: MEASURE

Use this register to control several measurement settings.

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REGISTER DETAILS

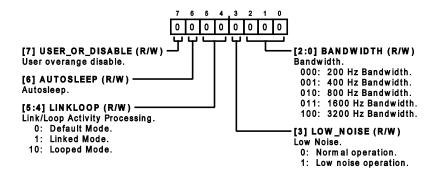


Figure 99.

Table 66. Bit Descriptions for MEASURE

Bits	Bit Name	Settings	Description	Reset	Access
7	USER_OR_DISABLE		User overange disable.	0x0	R/W
6	AUTOSLEEP		Autosleep. When set to 1, autosleep is enabled, and the device enters wake-up mode automatically upon detection of inactivity. Activity and inactivity detection must be in linked mode or loop mode (the LINKLOOP bits in the MEASURE register) to enable autosleep; otherwise, the bit is ignored.	0x0	R/W
5:4]	LINKLOOP		Link/Loop Activity Processing. These bits select how activity and inactivity processing are linked.	0x0	R/W
		0	Default Mode. Activity and inactivity detection, when enabled, operate simultaneously and their interrupts (if mapped) must be acknowledged by the host processor by reading the status register. Autosleep is disabled in this mode.		
		1	Linked Mode. Activity and inactivity detection are linked sequentially such that only one is enabled at a time. Their interrupts (if mapped) must be acknowledged by the host processor by reading the status register.		
		10	Looped Mode. Activity and inactivity detection are linked sequentially such that only one is enabled at a time, and their interrupts are internally acknowledged (do not need to be serviced by the host processor). To use either linked or looped mode, both ACT_x_EN and INACT_x_EN must be set to 1; otherwise, the default mode is used. For additional information, refer to the Linking Activity and Inactivity Detection section.		
	LOW_NOISE		Low Noise. Selects low noise operation.	0x0	R/W
		0	Normal operation. Device operates at the normal noise level and ultralow current consumption		
		1	Low noise operation. Device operates at ~1/3 the normal noise level.		
::0]	BANDWIDTH		Bandwidth. Select the desired output signal bandwidth. A 4-pole low-pass filter at the selected frequency limits the signal bandwidth.	0x0	R/W
		000	200 Hz Bandwidth.		
		001	400 Hz Bandwidth.		
		010	800 Hz Bandwidth.		
		011	1600 Hz Bandwidth.		
		100	3200 Hz Bandwidth.		

POWER CONTROL REGISTER

Address: 0x3F, Reset: 0x00, Name: POWER_CTL

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REGISTER DETAILS

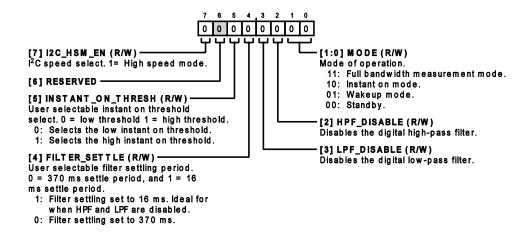


Figure 100.

Table 67. Bit Descriptions for POWER_CTL

Bits	Bit Name	Settings	Description	Reset	Access
7	I2C_HSM_EN		I ² C speed select. 1 = high speed mode.	0x0	R/W
6	RESERVED		Reserved.	0x0	R
5	INSTANT_ON_THRESH		User selectable instant on threshold select. 0 = low threshold, 1 = high threshold.	0x0	R/W
		0	Selects the low instant on threshold.		
		1	Selects the high instant on threshold.		
4	FILTER_SETTLE		User selectable filter settling period. 0 = 370 ms settle period, and 1 = 16 ms settle period.	0x0	R/W
		0	Filter settling set to 370 ms.		
		1	Filter settling set to 16 ms. Ideal for when the high-pass filter and the low-pass activity detect filter are disabled.		
3	LPF_DISABLE		Disables the digital low-pass activity detect filter.	0x0	R/W
2	HPF_DISABLE		Disables the digital high-pass filter.	0x0	R/W
[1:0]	MODE		Mode of operation.	0x0	R/W
		11	Full bandwidth measurement mode.		
		10	Instant on mode.		
		01	Wake up mode.		
		00	Standby.		

SELF TEST REGISTER

Address: 0x40, Reset: 0x00, Name: SELF_TEST

Refer to the Self Test section for information on the operation of the self test feature, and see the Self Test Procedure section for guidelines on how to use this functionality.

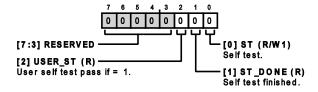


Figure 101.

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REGISTER DETAILS

Table 68. Bit Descriptions for SELF_TEST

Bits	Bit Name	Settings	Description	Reset	Access
[7:3]	RESERVED		Reserved.	0x0	R
2	USER_ST		User self test pass if = 1.	0x0	R
1	ST_DONE		Self test finished.	0x0	R
0	ST		Self test. Writing a 1 to this bit initiates self test. Writing a 0 clears self test.	0x0	R/W1

RESET (CLEARS) REGISTER, PART IN STANDBY MODE

Address: 0x41, Reset: 0x00, Name: RESET

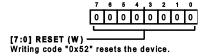


Figure 102.

Table 69. Bit Descriptions for RESET

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	Reset		Writing code 0x52 resets the device.	0x0	W

FIFO ACCESS REGISTER

Address: 0x42, Reset: 0x00, Name: FIFO_DATA

Read this register to access data stored in the FIFO.

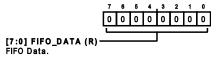


Figure 103.

Table 70. Bit Descriptions for FIFO_DATA

Bits	Bit Name	Settings	Description	Reset	Access
[7:0]	FIFO_DATA		FIFO Data. A read to this address pops a 2-byte word of axis data from the FIFO. FIFO data is formatted to 2 bytes (16 bits), most significant byte first. Two subsequent reads complete the transaction of this data onto the interface. Continued reading of this field continues to pop the FIFO every third read. Multibyte reads to this address do not increment the address pointer. If this address is read due to an auto-increment from the previous address, it does not pop the FIFO. It returns zeros and increment on to the next address.	0x0	R

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APPLICATIONS INFORMATION

APPLICATION EXAMPLES

This section includes a few application circuits, highlighting useful features of the ADXL372.

Power Supply Decoupling

Figure 104 shows the recommended bypass capacitors for use with the ADXL372.

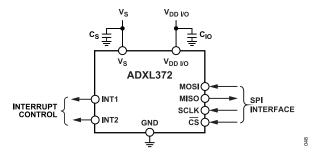


Figure 104. Recommended Bypass Capacitors

A 0.1 μ F ceramic capacitor (C_S) at V_S and a 0.1 μ F ceramic capacitor (C_{IO}) at V_{DDI/O} placed as close as possible to the ADXL372 supply pins are recommended to adequately decouple the accelerometer from noise on the power supply. It is recommended that V_S and V_{DDI/O} be separate supplies to minimize digital clocking noise on the V_S supply. If this is not possible, additional filtering of the supplies may be necessary.

If additional decoupling is necessary, a resistor or ferrite bead, no larger than 100 $\Omega,$ in series with $V_S,$ is recommended. Additionally, increasing the bypass capacitance on V_S to a 1 μF tantalum capacitor in parallel with a 0.1 μF ceramic capacitor may also improve noise.

Ensure that the connection from the ADXL372 ground to the power supply ground has low impedance because noise transmitted through ground has an effect similar to noise transmitted through $V_{\rm S}$.

Power Supply Requirements

The ADXL372 is designed to operate using supply voltage rails ranging from 1.6 V to 3.6 V. The operating voltage range (V_S) ranges from 1.6 V to 3.3 V to account for inaccuracies and transients of up to $\pm 10\%$ on the supply voltage.

Always start up the ADXL372 from 0 V. When the device is in operation, any time power is removed from the ADXL372, or falls below the operating voltage range, discharge the supplies (VS, VDD I/O, and any bypass capacitors) completely before power is reapplied. To enable supply discharge, it is recommended to power the device from a micro-controller GPIO, connect a shutdown discharge switch to the supply, or use a voltage regulator with a shutdown discharge feature, such as the ADP160.

When power cycling, if the ADXL372 cannot be discharged fully to 0 V, care must be taken regarding the following specifications:

- V_{RESET}
- ▶ Hold time
- ▶ Rise time

VRESET

During start-up or power cycling of the ADXL372, any time power is removed from the ADXL372 or falls to less than 1.6 V, the V_S and $V_{DD\ I/O}$ supply must be discharged to a reset voltage (V_{RESET}) \leq 100 mV before powering back up. The V_{RESET} specification is a mandatory requirement.

Hold Time

 V_S and $V_{DD\ I/O}$ supplies must be held below V_{RESET} for at least 200 ms before powering back up.

Rise Time

For the worst case scenario (V_{RESET} = 100 mV and hold time = 200 ms), the V_{S} and $V_{DD \parallel/O}$ supply rise time must be linear and within 250 μ s to reach 1.6 V (see Figure 105).

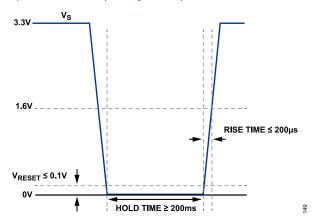


Figure 105. Power Cycling Requirements

Note that fully discharging the power supply to the ground level allows a longer rise time, ≤600 µs, from 0 V to 1.6 V for a 200 ms hold time.

Using External Timing Triggers

Figure 106 shows an application diagram for using the INT1 pin as the input for an external clock. In this mode, the external clock determines all accelerometer timing, including the output data rate and bandwidth.

Set the EXT CLK bit in the TIMING register to enable this feature.

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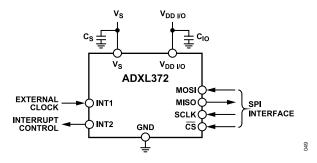


Figure 106. INT1 Pin as Input for External Clock

Figure 107 is an application diagram for using the INT2 pin as a trigger for synchronized sampling. Acceleration samples are produced every time this trigger is activated. Set the EXT_SYNC bit in the TIMING register to enable this feature.

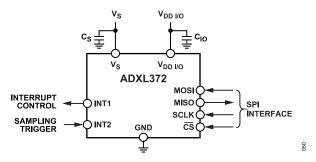


Figure 107. Using the INT2 Pin to Trigger Synchronized Sampling

OPERATION AT VOLTAGES OTHER THAN 2.5 V

The ADXL372 is tested and specified at a supply voltage of V_S = 2.5 V; however, it can be powered with a V_S as high as 3.5 V or as low as 1.6 V. Some performance parameters change as the supply voltage changes, including the supply current, noise, offset, and sensitivity.

OPERATION AT TEMPERATURES OTHER THAN AMBIENT

The ADXL372 is tested and specified at an ambient temperature; however, it is rated for temperatures between -40°C and +105°C.

Some performance parameters change along with temperature, such as offset, sensitivity, clock performance, and current. Some of these temperature variations are characterized in Table 1, and others are shown in the figures within the Typical Performance Characteristics section.

MECHANICAL CONSIDERATIONS FOR MOUNTING

Mount the ADXL372 on the PCB in a location close to a hard mounting point of the PCB to the case. Mounting the ADXL372 at an unsupported PCB location, as shown in Figure 108, can result in large, apparent measurement errors due to undamped PCB vibration. Locating the accelerometer near a hard mounting point ensures that any PCB vibration at the accelerometer is above the mechanical sensor resonant frequency of the accelerometer and, therefore, effectively invisible to the accelerometer. Multiple mounting points, close to the sensor, and/or a thicker PCB also help to reduce the effect of system resonance on the performance of the sensor.

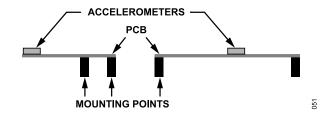


Figure 108. Incorrectly Placed Accelerometers

AXES OF ACCELERATION SENSITIVITY

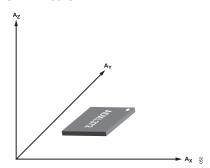


Figure 109. Axes of Acceleration Sensitivity (Corresponding Output Increases When Accelerated Along the Sensitive Axis)

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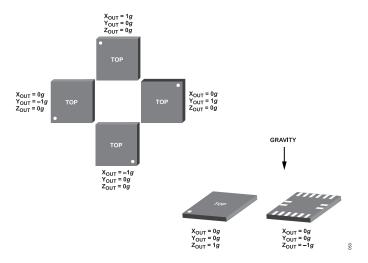


Figure 110. Output Response vs. Orientation to Gravity

LAYOUT AND DESIGN RECOMMENDATIONS

Figure 111 shows the recommended printed wiring board land pattern.

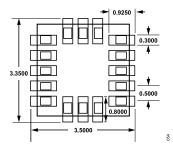


Figure 111. Recommended Printed Wiring Board Land Pattern (Dimensions Shown in Millimeters)

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SILICON ANOMALY

This anomaly list describes the known bugs, anomalies, and workarounds for the ADXL372.

Analog Devices, Inc., is committed, through future silicon revisions, to continuously improving silicon functionality. Analog Devices tries to ensure that these future silicon revisions remain compatible with your present software/systems by implementing the recommended workarounds outlined here.

ADXL372 FUNCTIONALITY ISSUES

Table 71. ADXL372 Functionality Issues

Silicon Revision Identifier	Silicon Status	Anomaly Sheet	Number of Reported Anomalies
0x03	Released	Rev. 0	3

FUNCTIONALITY ISSUES

Table 72. Automated Self Test [er001]

Background	
Dackground	

Issue

Workaround

The automated self test returns the USER_ST bit equal to Logic 1 on when the self test is successful (for example, the MEMS mechanical structure reacted as expected to the self test stimulus), and a Logic 0 when self test has failed (for example, the sensor is stuck).

The automated self test returns the USER_ST bit equal to Logic 0 even when the device is fully functional (for example, sensor moves freely and acceleration data is accurate).

Implement a software routine to determine the self test results by analyzing the z-axis acceleration data (Register 0x0C and Register 0x0D) from the moment the ST bit is set (self test starts) until ST_DONE is asserted (self test function has been completed). Figure 112 describes the self test profile from when the self test function is initiated (ST bit = 1) until it has been completed (ST_DONE = 1). The self test is considered successful if $|\Delta ST|$ is greater than 5 LSBs. The recommended self test procedure is as follows:

- 1. Reset the ADXL372.
- 2. Ensure that the low-pass filter is enabled.
- 3. Place the device in measurement mode.
- Wait until the filter settling time passes.
- 5. Start the self test by setting the ST bit in the SELF TEST register (Register 0x40). High-pass automatically disables.
- 6. Read the acceleration data from the z-axis (Register 0x0C and Register 0x0D) and store the data until the self test completes (ST_DONE goes high).
- 7. Average the first 50 ms of data right after ST is set.
- 8. Average the last 50 ms of data right before ST DONE goes high.
- 9. If the absolute value of the difference between the two averaged values is greater than 5 LSB, the self test passes.

During the deviation of the z-axis, the x-axis, and the y-axis also show deviation, which is normal. However, the outputs of the x-axis and y-axis cannot be used to qualify a pass or fail of the self test.

Related Issues

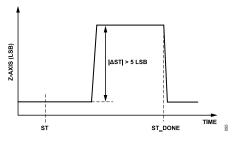


Figure 112. Self Test Waveform

Table 73. FIFO Error [er002]

Background Issue

Data must be stored in the FIFO as an x, y, z, x, y, z, ... sequence.

In all FIFO modes, data misalignment occurs. Data may be stored in the FIFO as a y, z, x, y, z, x, ... sequence or a z, x, y, z, x, y, ... sequence.

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SILICON ANOMALY

Table 73. FIFO Error [er002]

Workaround	Leverage the external trigger synchronization function to disable the sensor ADC before accessing the FIFO (see Figure 113 for an implementation example).
	To initialize, follow these steps:
	1. Set the desired FIFO mode and other desired configurations.
	2. Set the timing register (0x3D) to external sync along with the ODR. Do not apply an external trigger signal to INT2 to keep the ADC of
	3. Set the device to measurement mode.
	For the main loop, follow these steps:
	1. Set the timing register (0x3D) to internal sync along with the ODR.
	2. Wait for the FIFO_FULL interrupt from INT1.
	3. Set the timing register (0x3D) to external sync along with the ODR.
	4. Read the entire content of the FIFO.
	5. Clear the FIFO (bypass mode).
	6. Set the desired FIFO mode.
Related Issues	None.

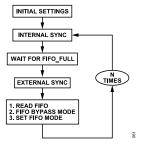


Figure 113. FIFO Workaround Implementation Example

Table 74. 1/5 of ODR Tone Error [er003]

	•	
Background	The ADXL372 must not present any tones within the bandwidth selected.	
Issue	The ADXL372 presents a tone at 1/5 of the output data rate.	
Workaround	RMS noise is specified considering the magnitude of the tone issue. For applications that require frequency analysis, use the ADXL371.	
	The tone issue is resolved in the ADXL371 and it is pin compatible with the ADXL372.	
Related Issues	None.	

Table 75. ADXL372 Functionality Issues

Table 1017127.27 21 allocations, locate			
Reference Number	Description	Status	
er001	The automated self test returns the USER_ST bit equal to Logic 0 even when the device is fully functional.	Identified	
er002	In all FIFO modes, data misalignment occurs.	Identified	
er003	1/5 of ODR tone error.	Identified	

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OUTLINE DIMENSIONS

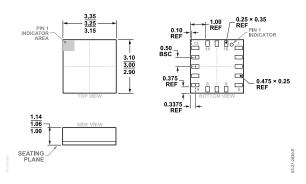


Figure 114. 16-Terminal Land Grid Array [LGA] (CC-16-4) Dimensions shown in millimeters

Updated: September 07, 2022

ORDERING GUIDE

,				Package
Model ¹	Temperature Range	Package Description	Packing Quantity	Option
ADXL372BCCZ-RL	-40°C to +105°C	16-Lead LGA (3mm x 3.25mm)	Reel, 5000	CC-16-4
ADXL372BCCZ-RL7	-40°C to +105°C	16-Lead LGA (3mm x 3.25mm)	Reel, 1500	CC-16-4

¹ Z = RoHS Compliant Part.

EVALUATION BOARDS

Model ¹	Description
EVAL-ADXL372Z	Breakout Board

¹ Z = RoHS Compliant Part.



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Analog Devices Inc.:

EVAL-ADXL372Z ADXL372BCCZ-RL7 ADXL372BCCZ-RL EVAL-ADXL372Z-M